

MODEL NAME: *NAP00*  
PCB NAME: *LA-5811P MB*  
COMPAL P/N: *DAA00001P00*

# Compal confidential

## Schematics Document

Intel CULV (SFF)

Penryn + Cantiga + ICH9-M

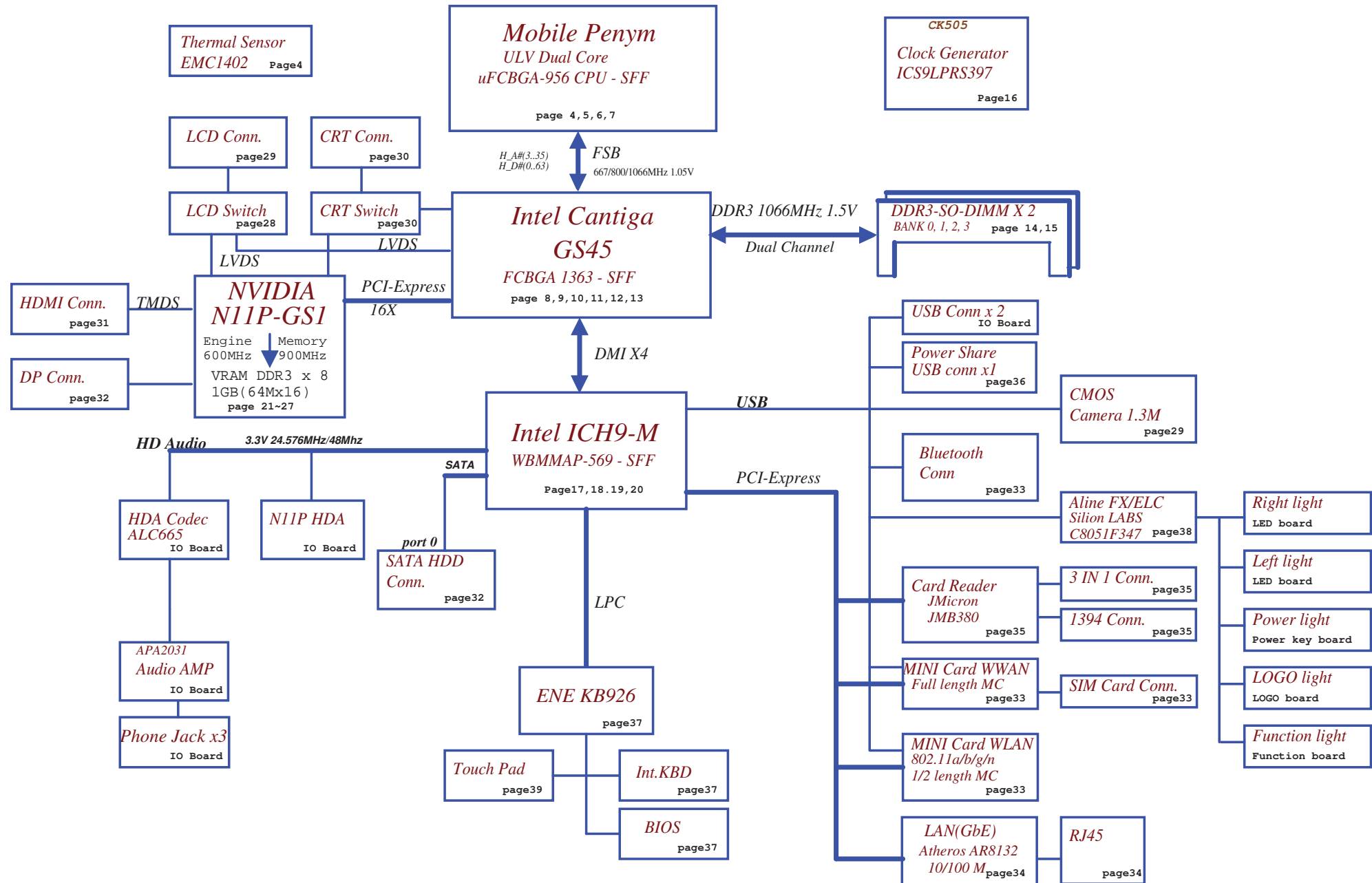
DISCRETE VGA N11P-GS1 (Switchable Graphics)

2009-12-16

Rev: 1.0

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# ULV



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## Voltage Rails ( O MEANS ON X MEANS OFF )

power plane State	B+	+5VALW +3VALW VL	+1.8V +1.5V	+5VS +3VS +0.75VS +VCCP +CPU_CORE
S0	O	O	O	O
S1	O	O	O	O
S3	O	O	O	X
S5 S4/AC	O	O	X	X
S5 S4/ Battery only	O	X	X	X
S5 S4/AC & Battery don't exist	X	X	X	X

### Symbol Note :

 : means Digital Ground

 : means Analog Ground

@ : means just reserve , no build

CONN@ : means ME part.

45@ : means install after SMT.

## I2C / SMBUS ADDRESSING

DEVICE	HEX	ADDRESS
EC_SMB_CK1 EC_SMB_DA1 Battery		
EC_SMB_CK2 EC_SMB_DA2 CPU THERMAL SENSOR (EMC1402-1-ACZL)	4C	01001100
GPU THERMAL SENSOR (ADM1032ARMZ)	4D	01001101
GPU INTERNAL THERMAL SENSOR	9E	10011110
ICH_SMBCLK ICH_SMBDATA CLOCK GENERATOR (EXT.)	D2	11010010
Free Fall Sensor	38	00111000

### Compal R1 PN

CPU-->SA00003I91L(S IC AV80577UG0132M SLGS4 R0 1.3G FCBGA)----->SU4100

CPU-->SA00003IA1L(S IC AV80577UG0133M SLGS6 R0 1.3G FCBGA)----->SU7300

NB-->SA00002RQ1L(S IC AC82GS45 SLB92 B3 FCBGA 1363)----->45180131L03,45180131L04

SB-->SA00001YC4L(S IC AM82801IUX SLB8N A FCBGA 569P ICH9M)-->45180131L03,45180131L04

VRAM-->SA00003240L(S IC D3 64M16 H5TQ1G63BFR-12C FBGA 96P)-->45180131L03,45180131L04

VRAM-->SA00003570L(S IC D3 64M16 K4W1G1646E-HC12 FBGA 96P)-->45180131L03,45180131L04

### Compal R3 PN

CPU-->SA00003I92L(S IC AV80577UG0132M SLGS4 R0 1.3G A31!)----->SU4100

CPU-->SA00003IA2L( S IC AV80577UG0133ML SLGYV R0 1.3G A31!)----->SU7300

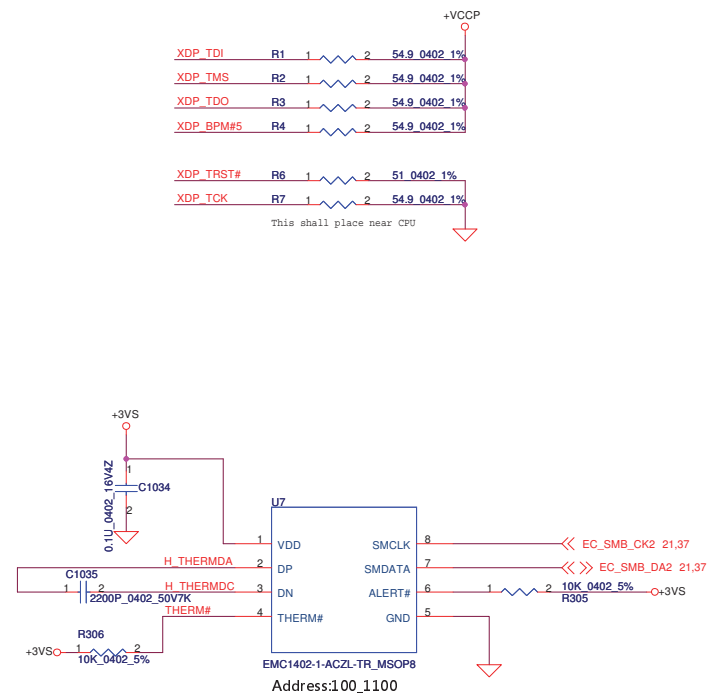
NB-->SA00002RQ0L(S IC AC82GS45 SLB92 B3 FCBGA 1363 A31 !)-->45180131L01,45180131L02

SB-->SA00001YC3L(S IC AM82801IUX SLB8N A FCBGA ICH9M A31!)-->45180131L01,45180131L02

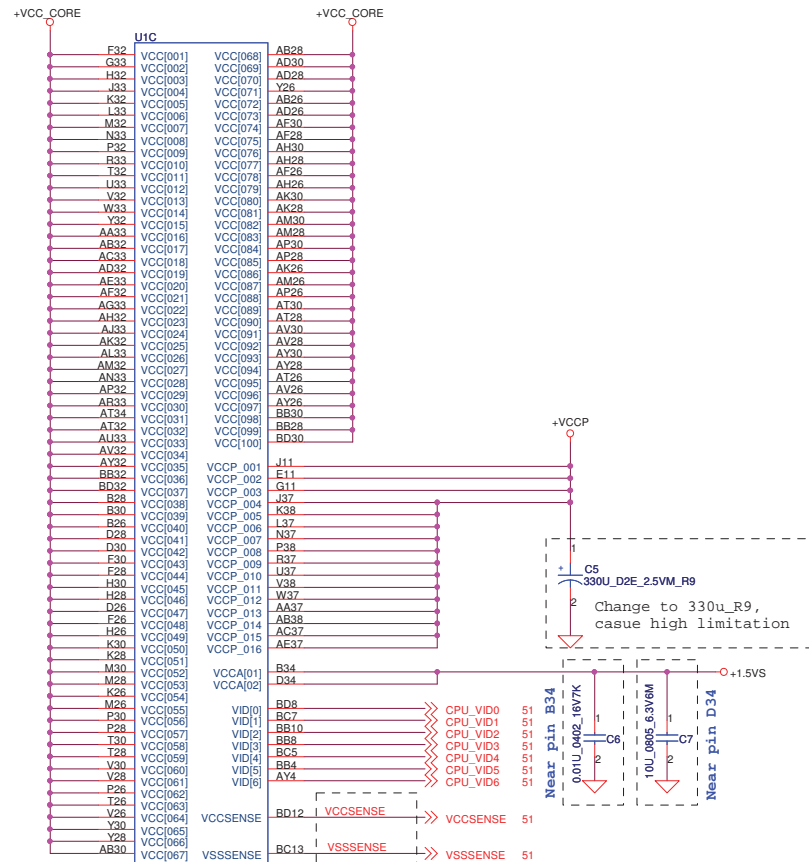
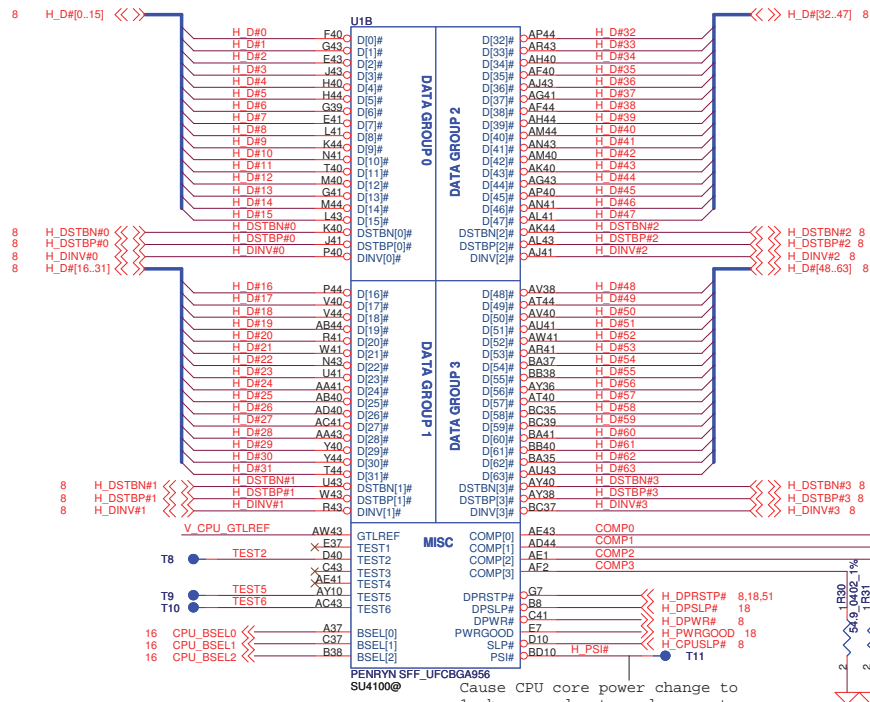
VRAM-->SA00003241L(S IC D3 64M16 H5TQ1G63BFR-12C FBGA A31!)-->45180131L01,45180131L02

VRAM-->SA00003571L(S IC D3 64M16 K4W1G1646E-HC12 FBGA A31!)-->45180131L01,45180131L02

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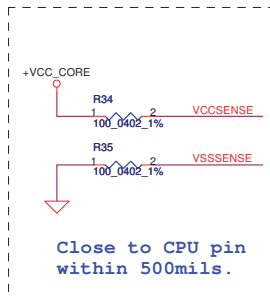
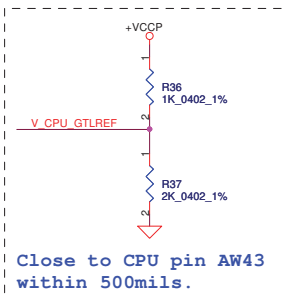
layout note: Route TEST3 & TEST5 traces on ground referenced layer to the TPs

CPU_BSEL	CPU_BSEL2	CPU_BSEL1	CPU_BSEL0
166	0	1	1
200	0	1	0
266	0	0	0

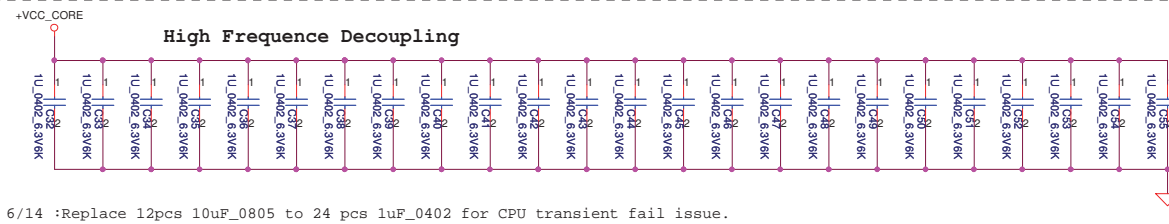
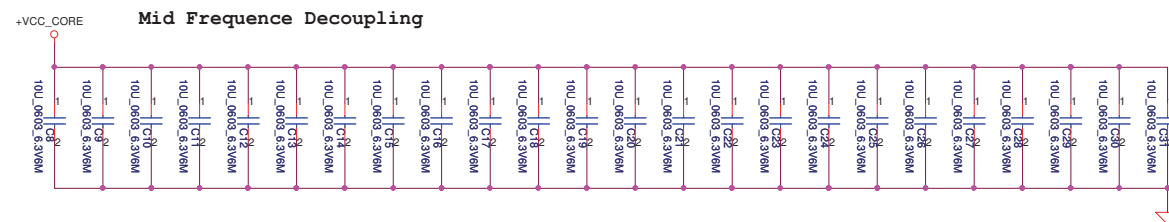
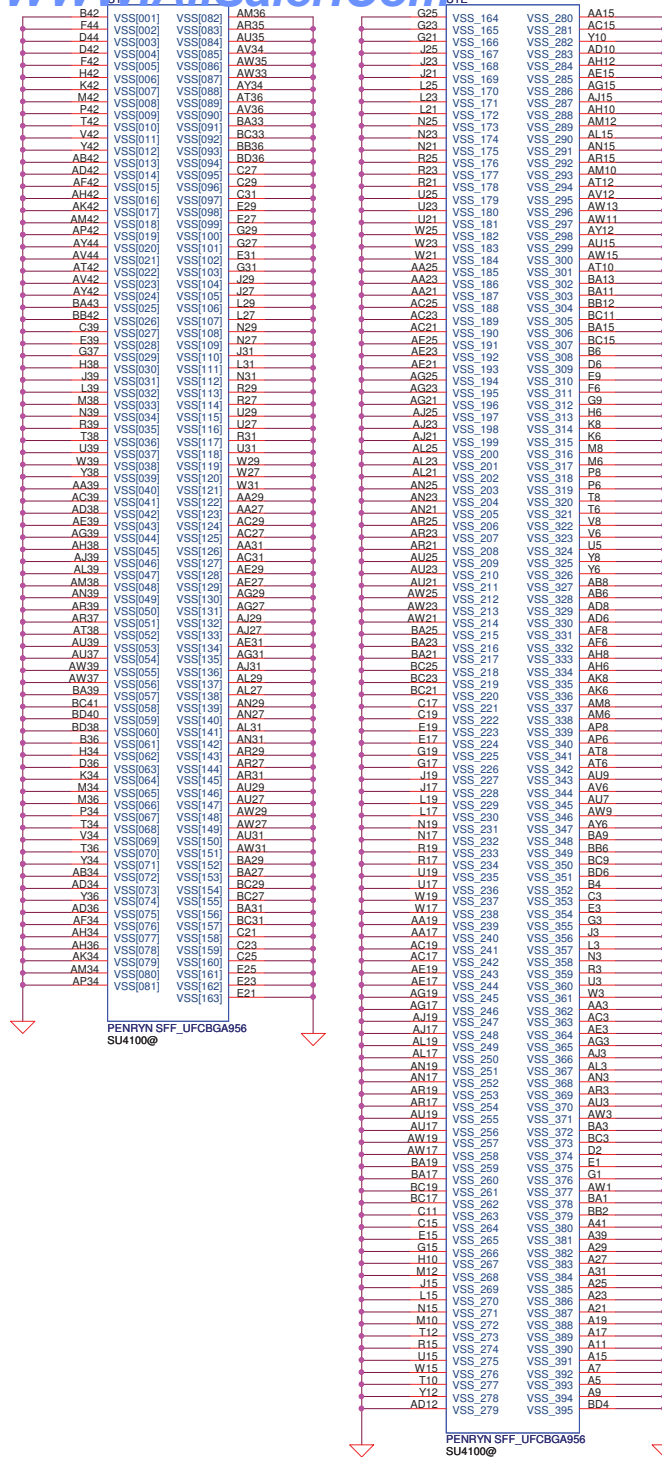
Resistor placed within 0.5" of CPU pin. Trace should be at least 25 mils away from any other toggling signal. COMP[0,2] trace width is 18 mils. COMP[1,3] trace width is 4 mils.

Causes CPU core power change to 1 phase, and not need support the pin, leave it as TP. 10/02

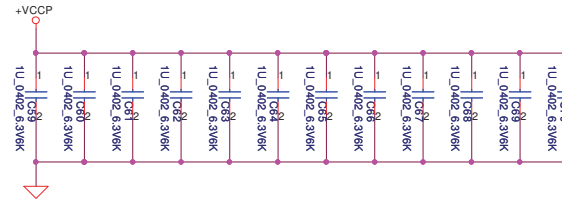
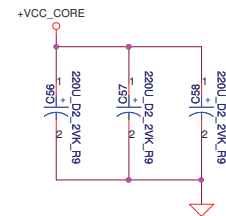
Length match within 25 mils. The trace width/space/other is 20/7/25.



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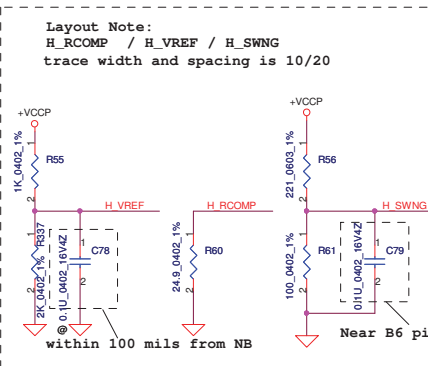


Near CPU CORE regulator



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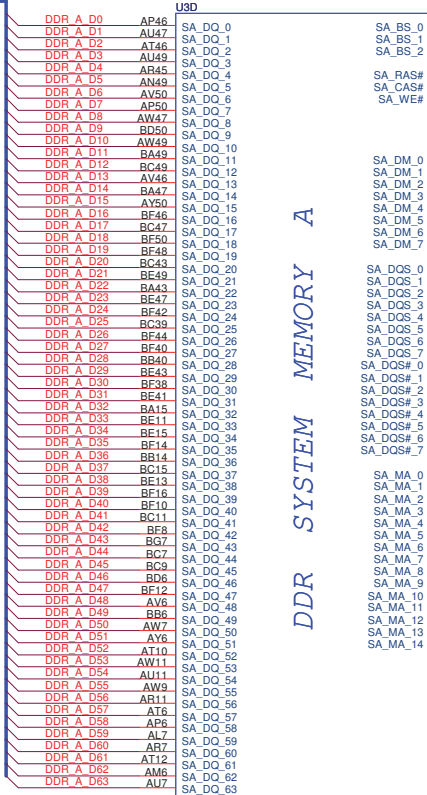




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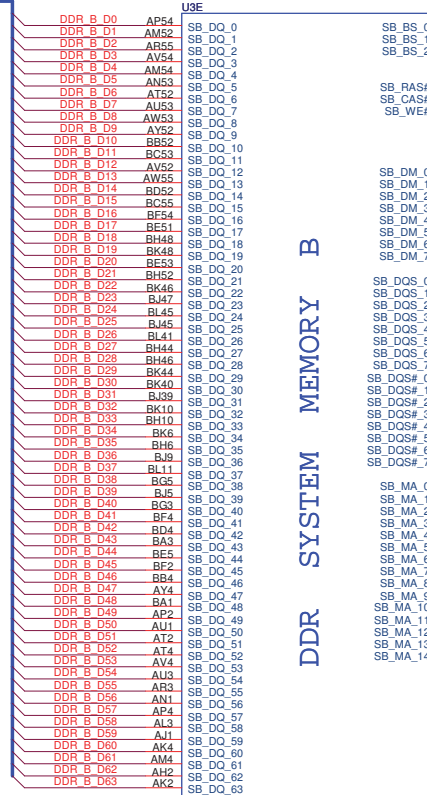


14 DDR\_A\_D[0..63] <<>



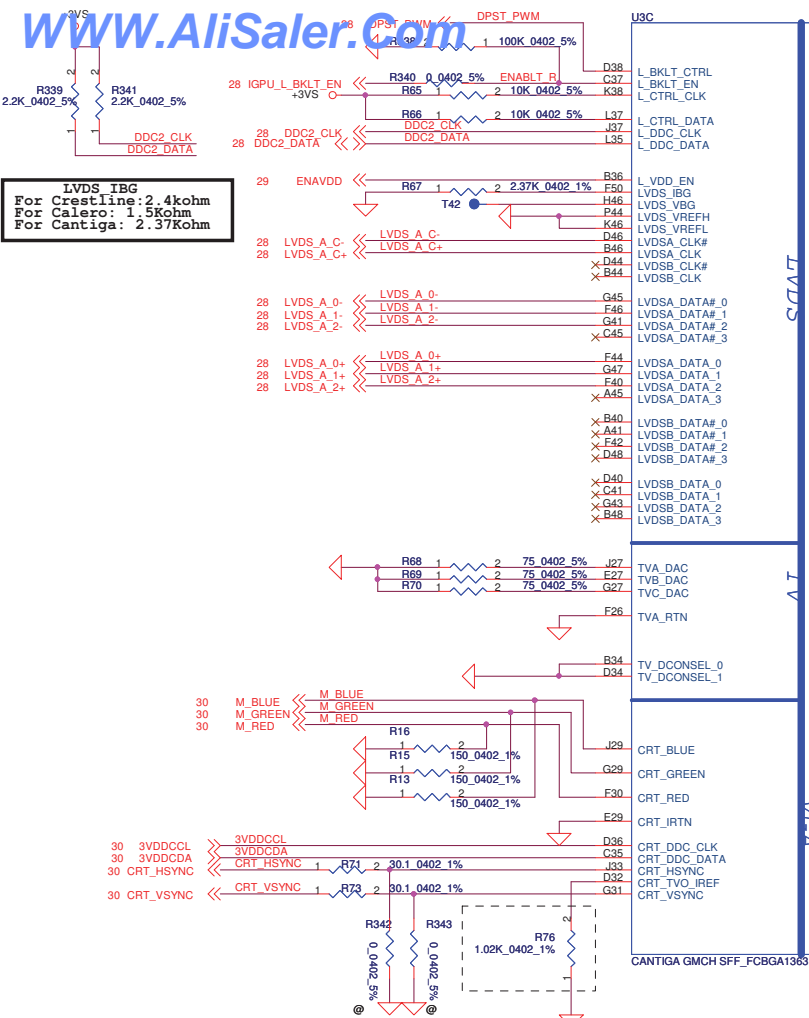
CANTIGA GMCH SFF\_FCBGA1363

15 DDR\_B\_D[0..63] <<>



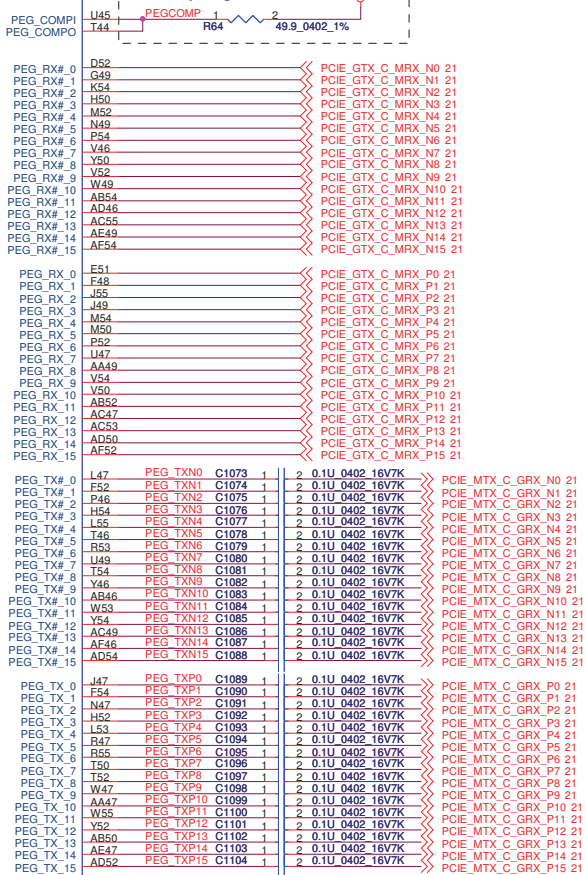
CANTIGA GMCH SFF\_FCBGA1363

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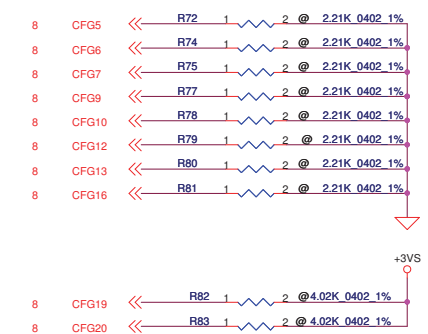
Close to pin D32 and keep 30mil space to other part/trace.

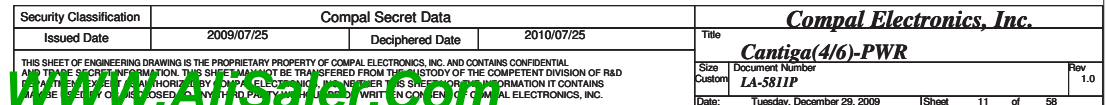
layout note: Place R64 <500mils to U4 pin U45&T44.



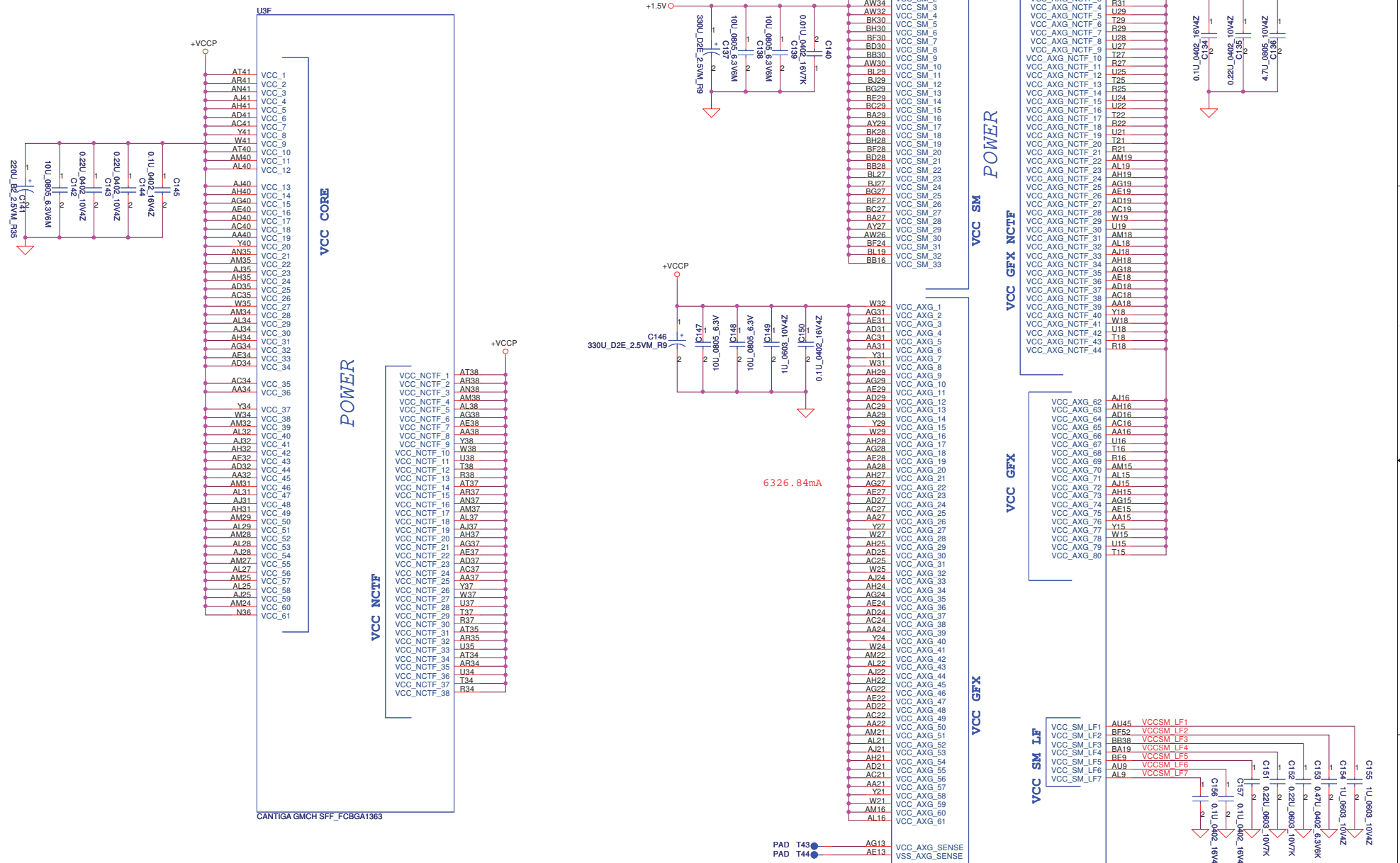
# Strap Pin Table

CFG[2:0] FSB Freq select	00 = FSB 1066MHz 010 = FSB 800MHz 011 = FSB 667MHz Others = Reserved
CFG[4:3]	Reserved
CFG5 (DMI select)	0 = DMI x 2 1 = DMI x 4 *
CFG6	0 = The iTPM Host Interface is enable 1 = The iTPM Host Interface is disable *
CFG7 (Intel Management Engine Crypto strap)	0 =(TLS)chiper suite with no confidentiality 1 =(TLS)chiper suite with confidentiality *
CFG8	Reserved
CFG9 (PCIe Graphics Lane Reversal)	0 = Reverse Lane,15->0, 14->1 1 = Normal Operation,Lane Number in order *
CFG10 (PCIe Lookback enable)	0 = Enable 1 = Disable *
CFG11	Reserved
CFG[13:12] (XOR/ALLZ)	00 = Reserved 01 = XOR Mode Enabled 10 = All Z Mode Enabled 11 = Normal Operation(Default) *
CFG[15:14]	Reserved
CFG16 (FSB Dynamic ODT)	0 = Disabled 1 = Enabled *
CFG[18:17]	Reserved
CFG19 (DMI Lane Reversal)	0 = Normal Operation * (Lane number in Order) 1 = Reverse Lane
CFG20 (PCIe/SDVO concurrent)	0 = Only PCIe or SDVO is operational. * 1 = PCIe/SDVO are operating simu.

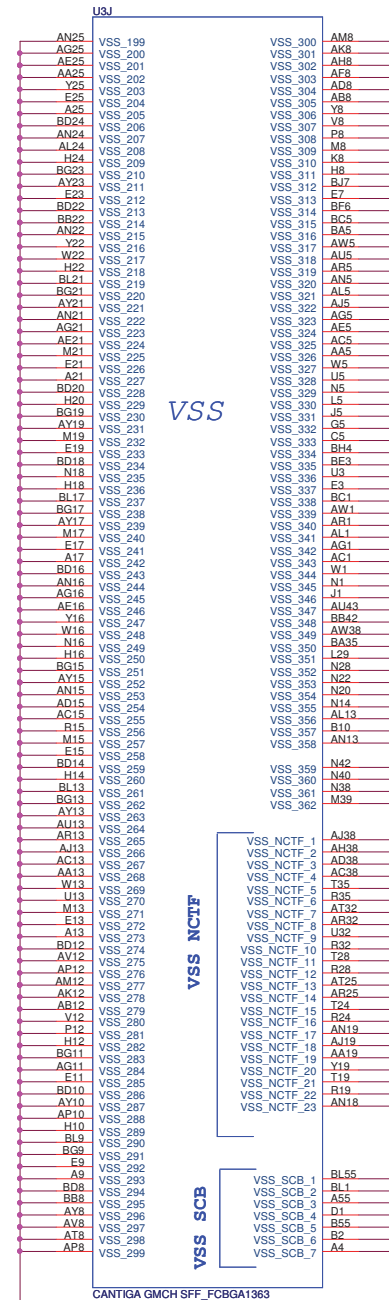
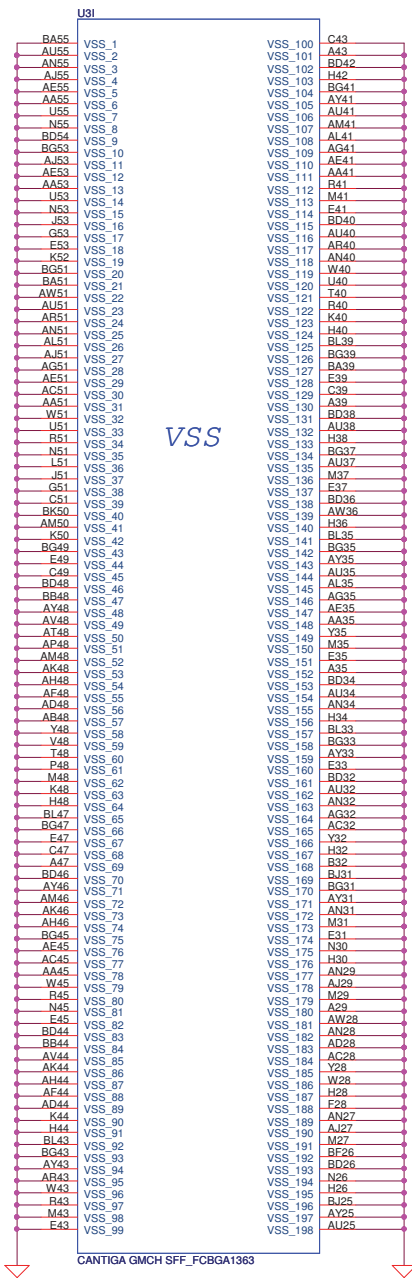




Extanal Graphic: 1210.34mA  
integrated Graphic: 1930.4mA



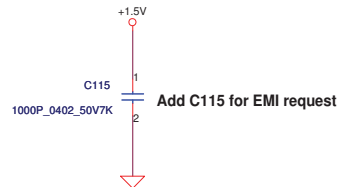
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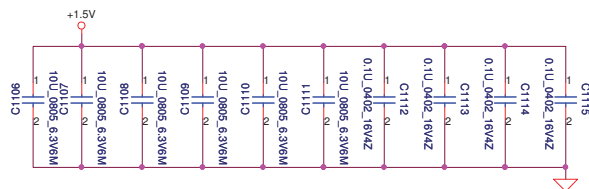


9 DDR\_A\_DQS#0..7 <<>>  
 9 DDR\_A\_D[0..63] <<>>  
 9 DDR\_A\_DM[0..7] <<>>  
 9 DDR\_A\_DQS#0..7 <<>>  
 9 DDR\_A\_MA[0..14] <<>>

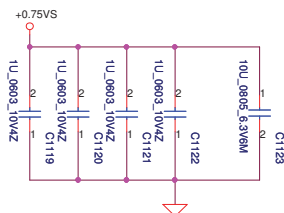


Layout Note:  
 Place near JDIMM1

Layout Note: Place these 4 Caps near Command and Control signals of DIMMA



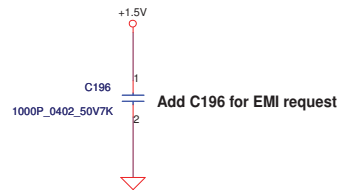
Layout Note:  
 Place near JDIMM1.203 & JDIMM1.204



DDR3 SO-DIMM A  
 5.2H Standard

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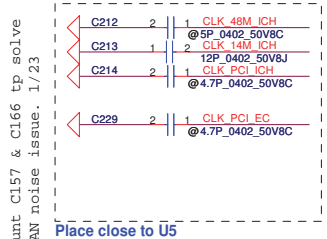
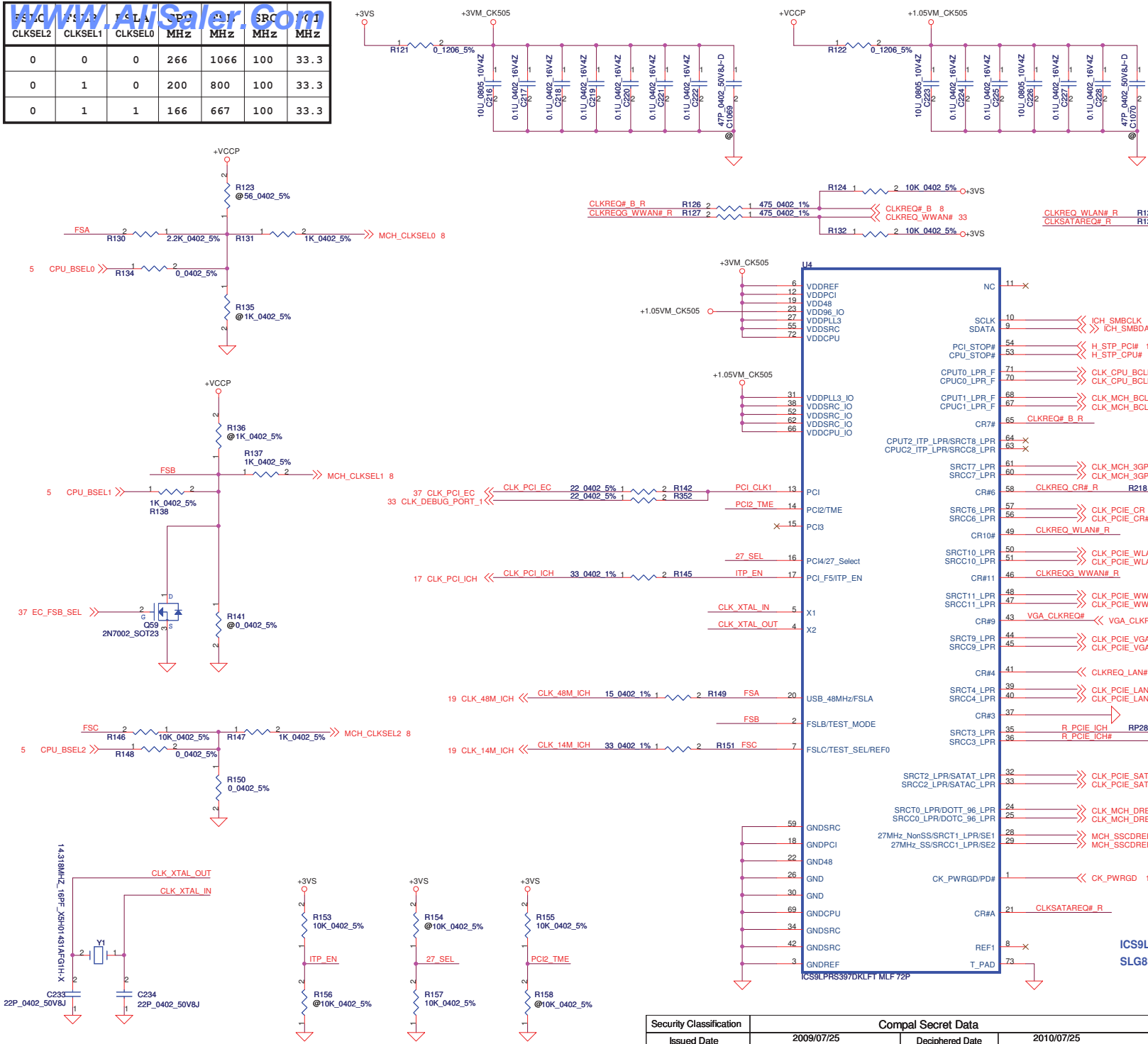
Layout Note: Place these 4 Caps near Command and Control signals of DIMMB



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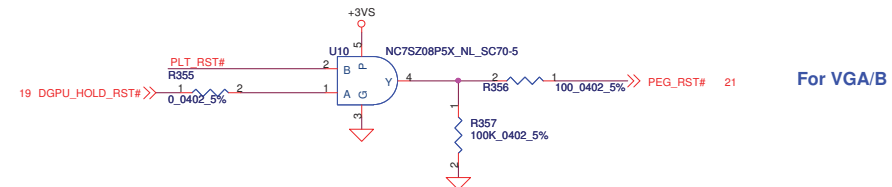
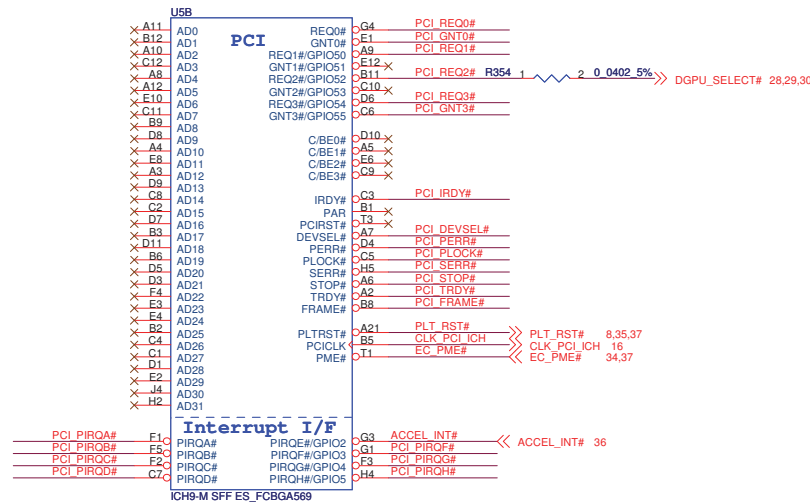
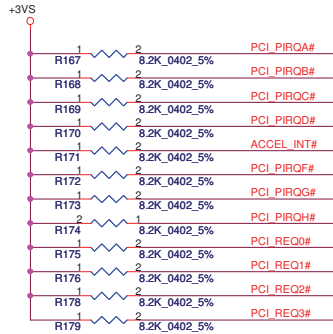
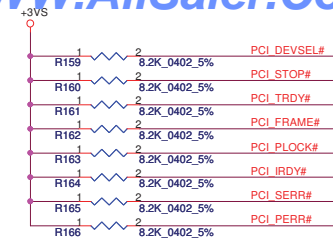
SEL1	SEL2	SEL1	SEL2	SEL1	SEL2	SEL1	SEL2
CLKSEL2	CLKSEL1	CLKSEL0	MHz	MHz	MHz	MHz	MHz
0	0	0	266	1066	100	33.3	
0	1	0	200	800	100	33.3	
0	1	1	166	667	100	33.3	



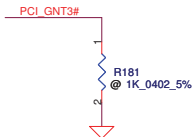
Place close to U5

Mount C157 & C166 tp solve WWAN noise issue. 1/23

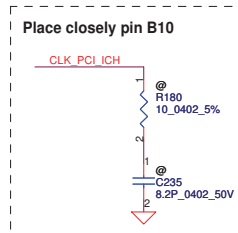
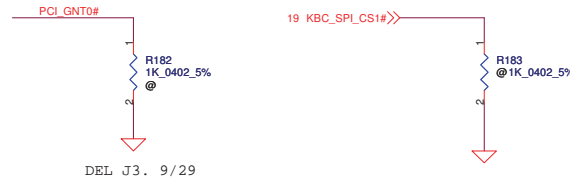
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A16 swap override Strap	
PCI_GNT3#	Low= A16 swap override Enble High= Default*

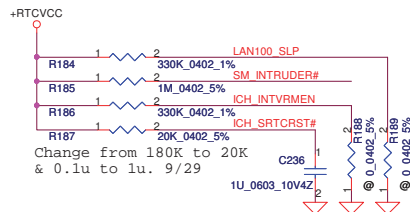


Boot BIOS Strap		
PCI_GNT0#	SPI_CS#1	Boot BIOS Location
0	1	SPI
1	0	PCI
1	1	LPC *

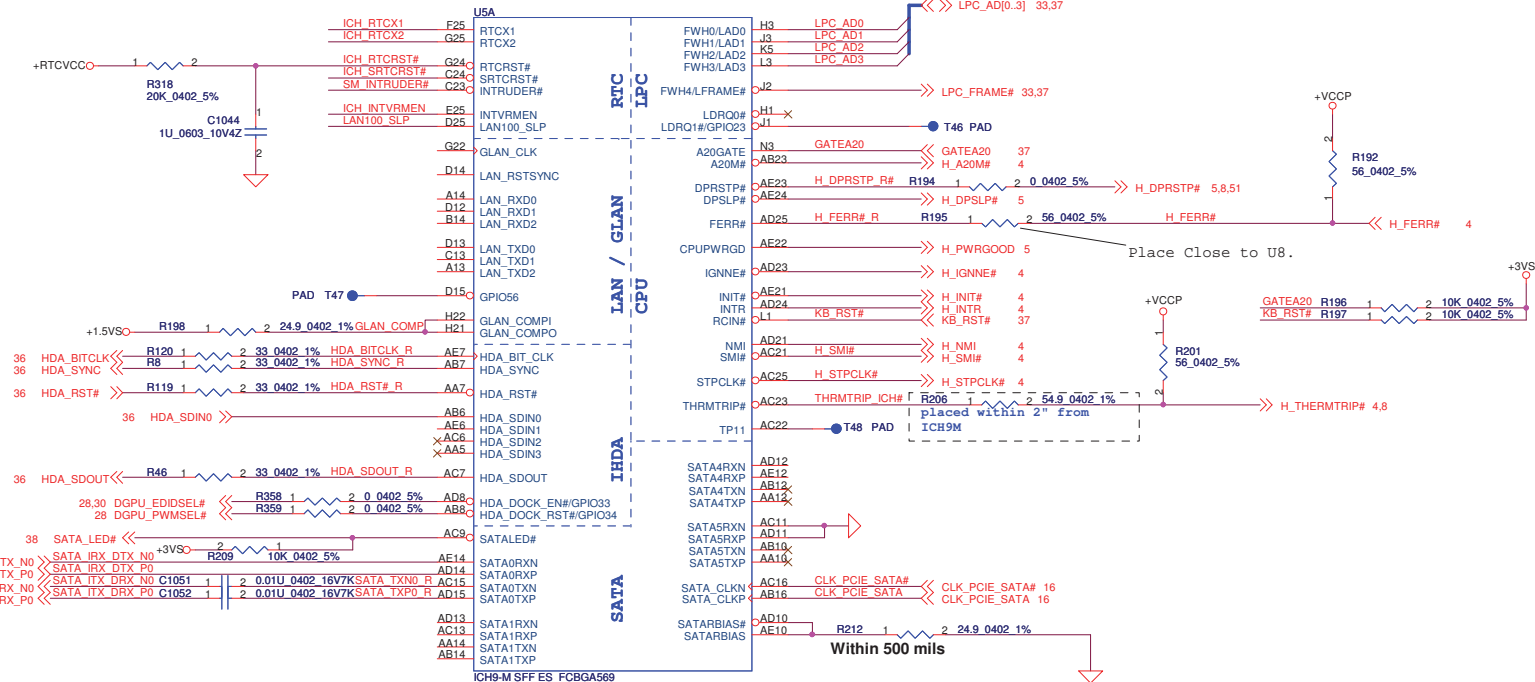
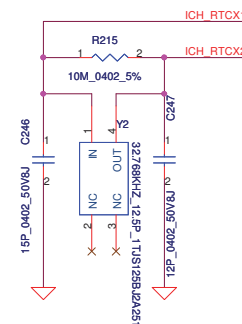


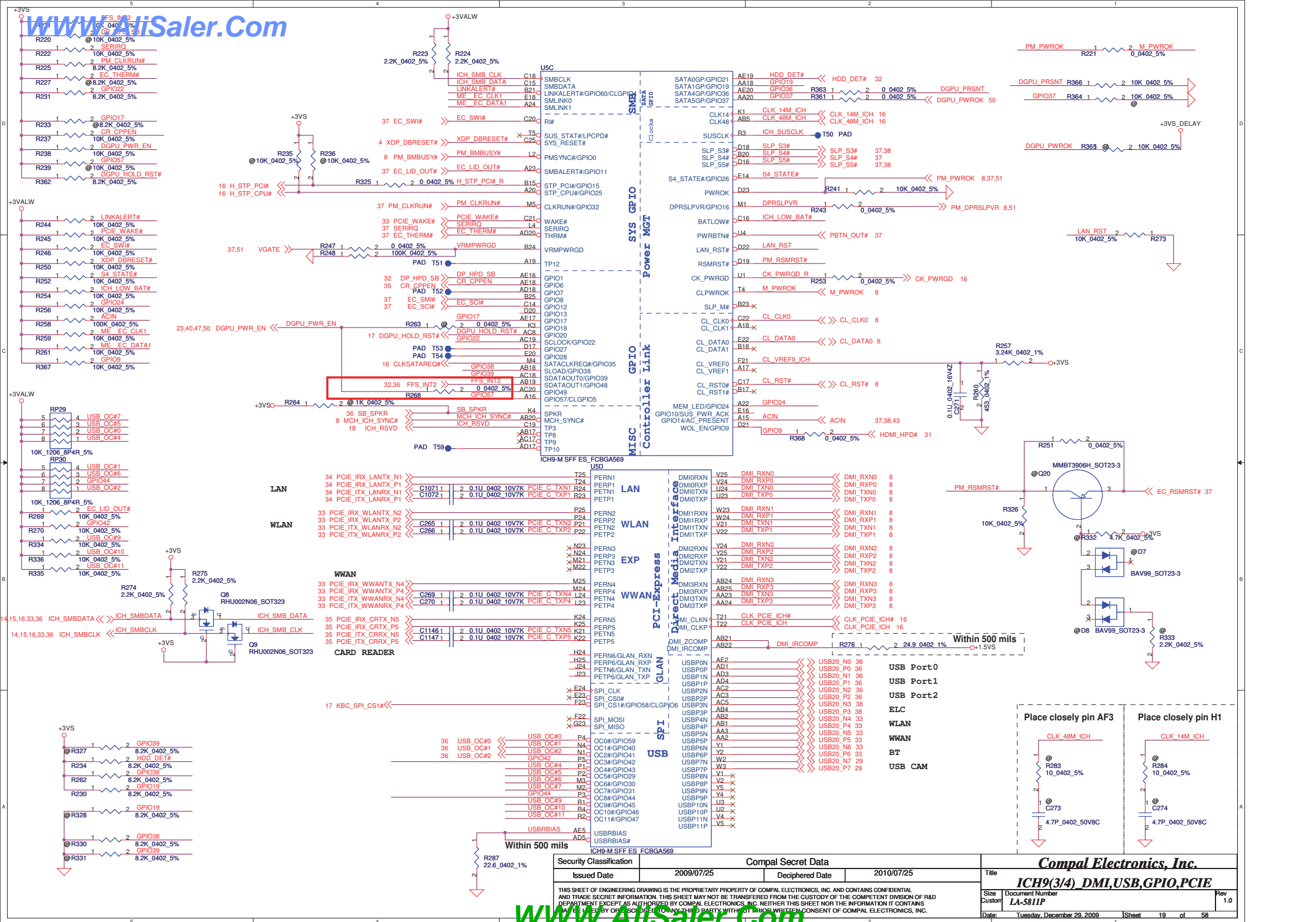
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				Date	Rev
				Tuesday, December 29, 2009	1.0
				Sheet	17 of 58

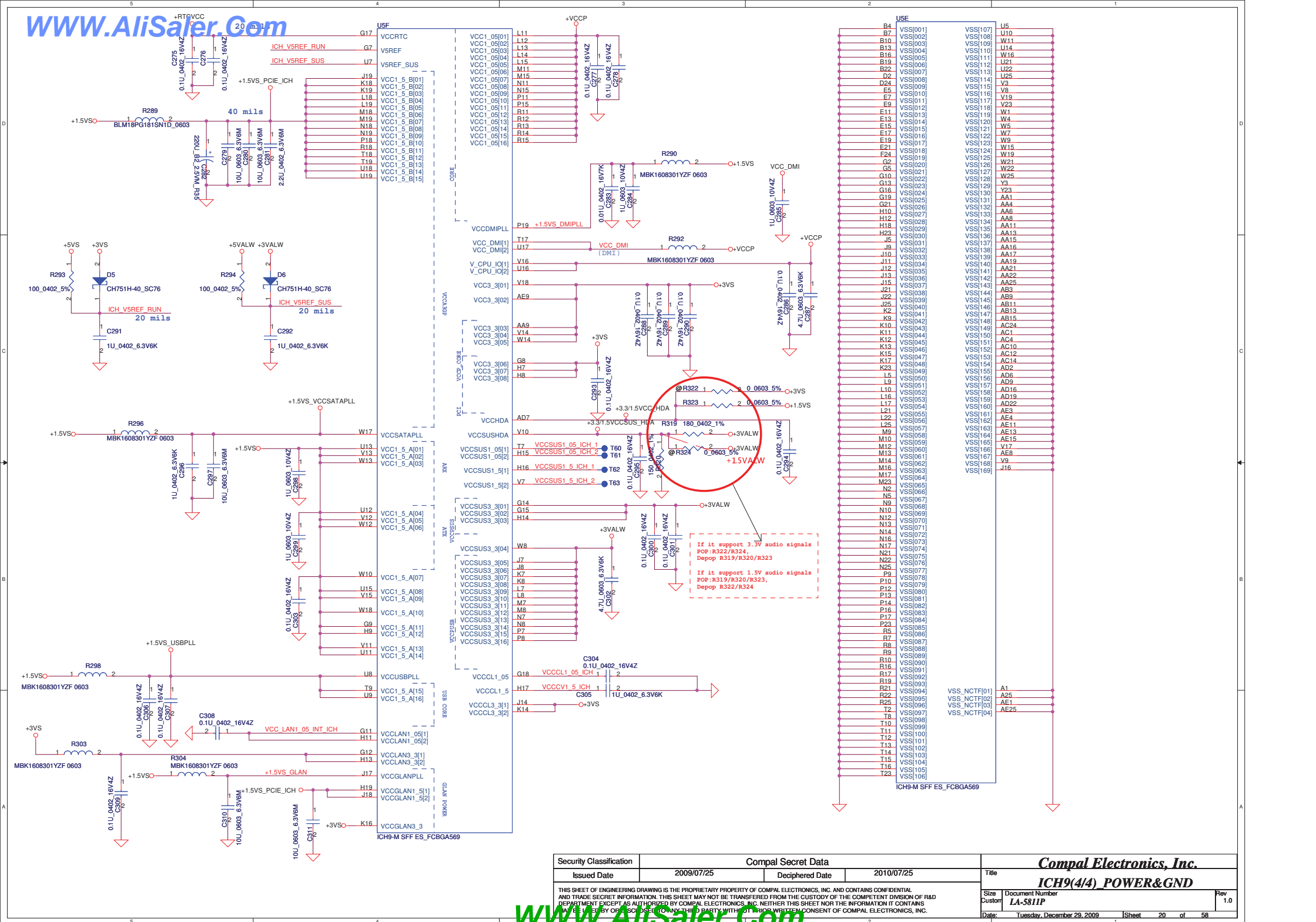
***Compal Electronics, Inc.***



<b>Compal Electronics, Inc.</b>			
Title			
<b>ICH9(2/4) LAN,HD,IDE,LPC</b>			
Size	Document Number		Rev
Custom	<b>LA-581IP</b>		<b>1.0</b>
Date:	Tuesday, December 29, 2009	Sheet	18 of 58

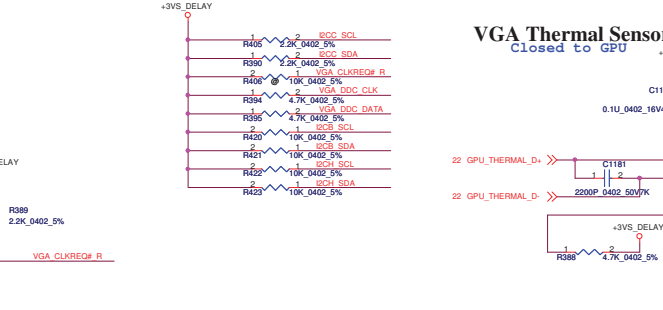
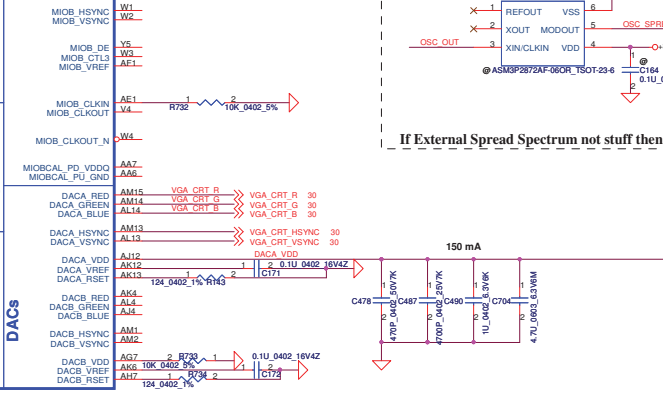
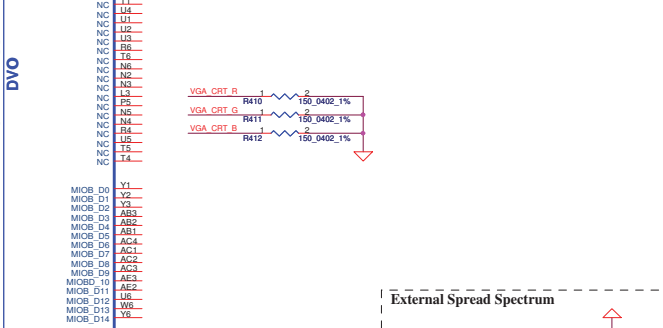
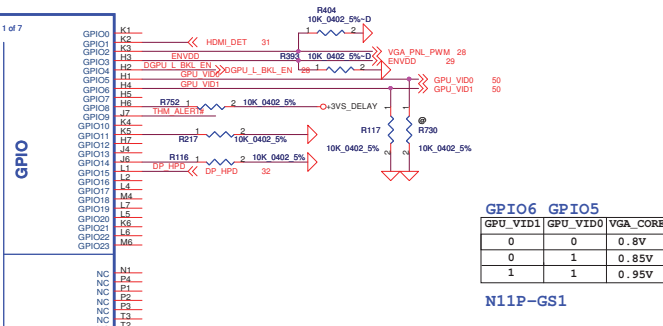
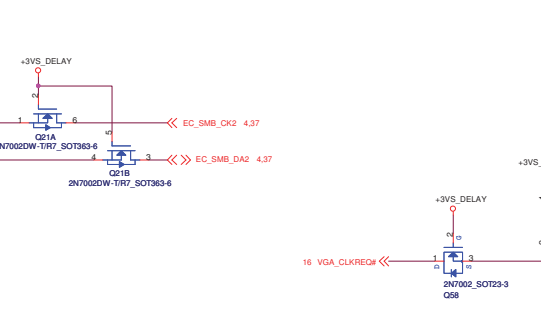
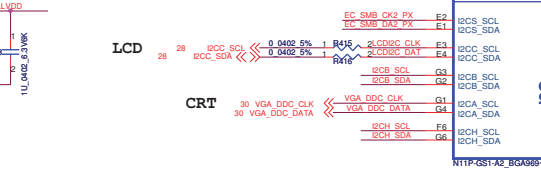
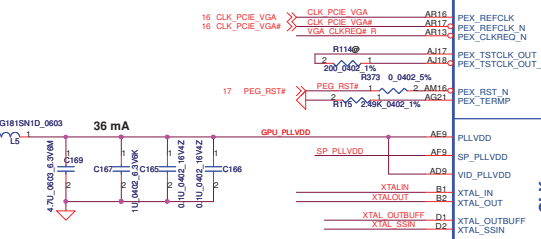
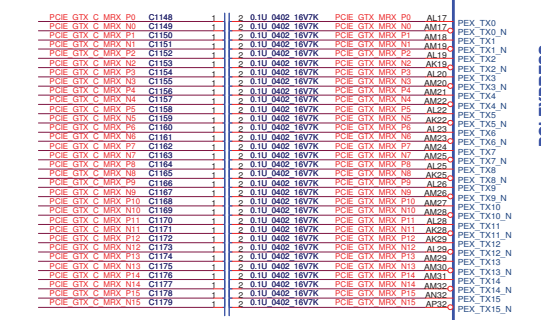




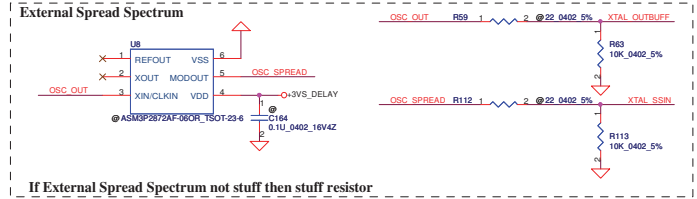
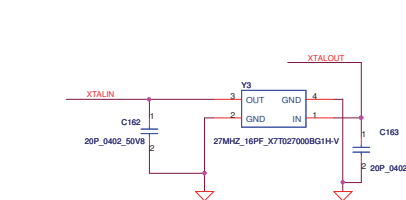


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Size	Document Number	Date		Sheet	Rev
Custord	LA-5811P	Tuesday, December 29, 2009		20	1.0
				of	58

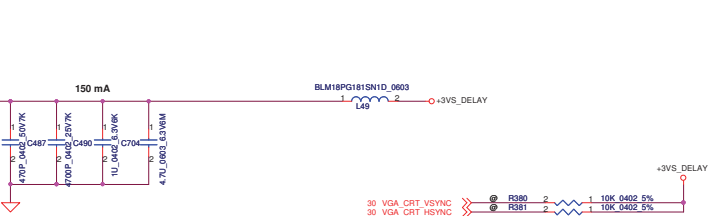




GPIO	I/O	ACTIVE	USAGE
GPIO0	IN	H	N/A
GPIO1	IN	H	HDMI Hot-plug
GPIO2	OUT	H	VGA_PNL_PWM
GPIO3	OUT	H	ENVDD
GPIO4	OUT	H	VGA_BKL_EN
GPIO5	OUT	N/A	NVVDD VID0
GPIO6	OUT	N/A	NVVDD VID1
GPIO7	IN	L	N/A
GPIO8	IN	L	N/A
GPIO9	IN	L	THM_ALERT#
GPIO10	OUT	N/A	N/A
GPIO11	OUT	N/A	N/A
GPIO12	IN	N/A	N/A
GPIO13	OUT	N/A	N/A
GPIO14	OUT	N/A	N/A
GPIO15	IN	H	DP Hot-plug

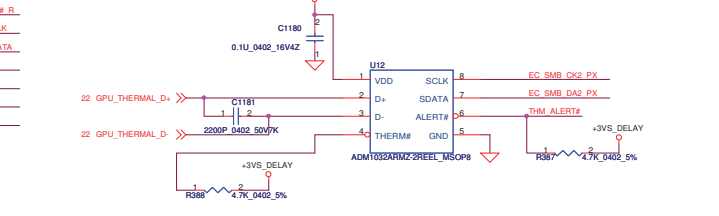


resistor

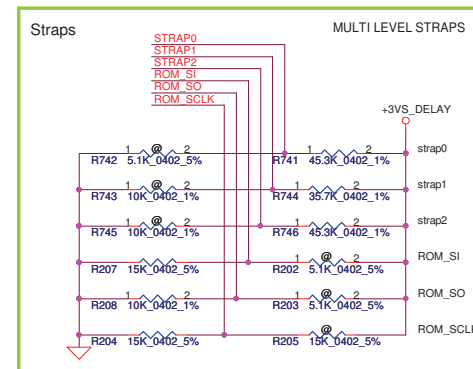


VGA\_CRT\_VSYNC and VGA\_CRT\_HSYNC  
pull up to HDMI & DISPLAY PORT AUDIO function

**VGA Thermal Sensor ADM1032ARMZ**  
Closed to GPU +3VS\_DELAY



Security Classification		Compal Secret Data		Title	
Issued Date	2009/07/25	Deciphered Date	2010/07/25	N11P-GS1(1/5)PCIE/STRAPS/THERM	
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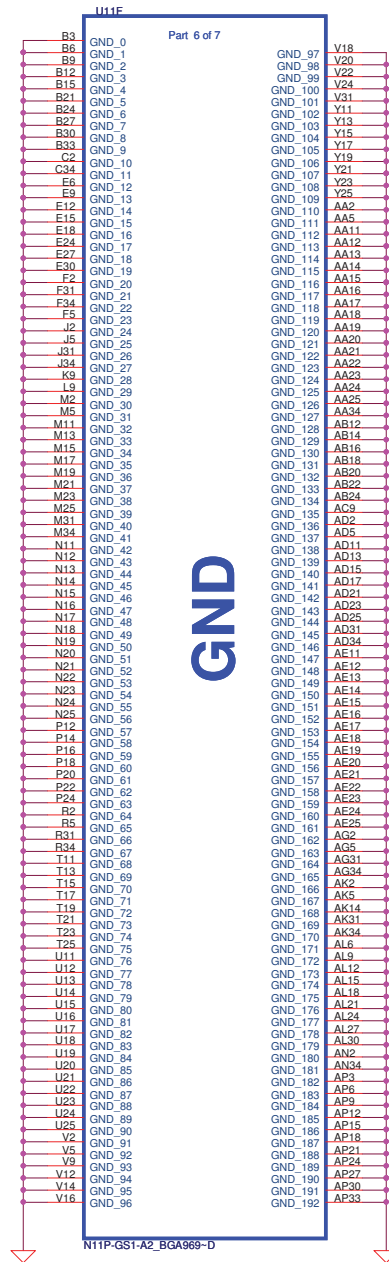
	strap0	strap1	strap2	ROM_SI	ROM_SO	ROM_SCL
64MX16 Samsung	H 45K	H 35K	H 30K	L 20K	L 10K	L 15K
64MX16 Hynix	H 45K	H 35K	H 30K	L 15K	L 10K	L 15K

Samsung:SA0000035700

Security Classification		Compal Secret Data		<b>Compal Electronics, Inc.</b> <b>N11P-GS1(2/5) IO</b>	
Issued Date	2009/07/25	Deciphered Date	2010/07/25	Title	
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					LA-5811P
				Date:	Rev
				Tuesday, December 29, 2009	1.0
				Sheet	24 of 58

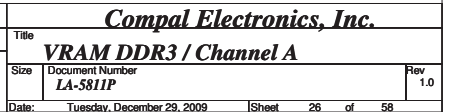


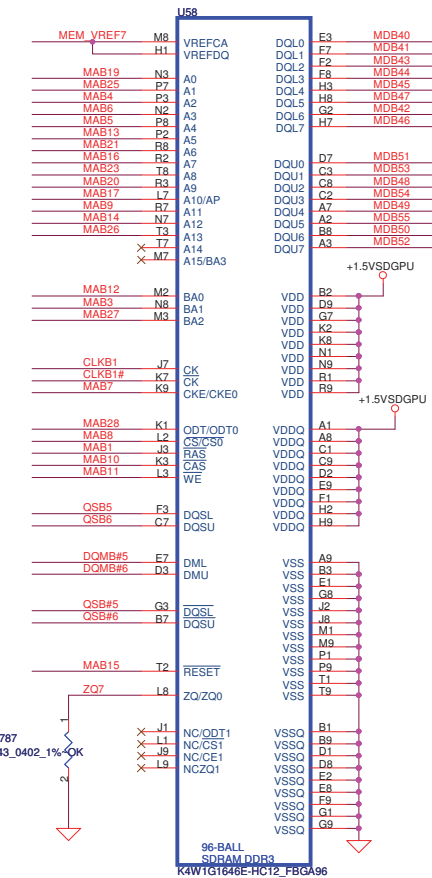
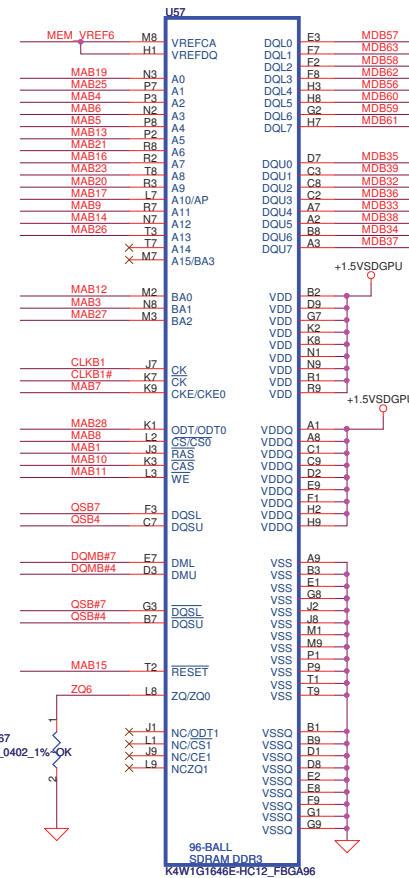
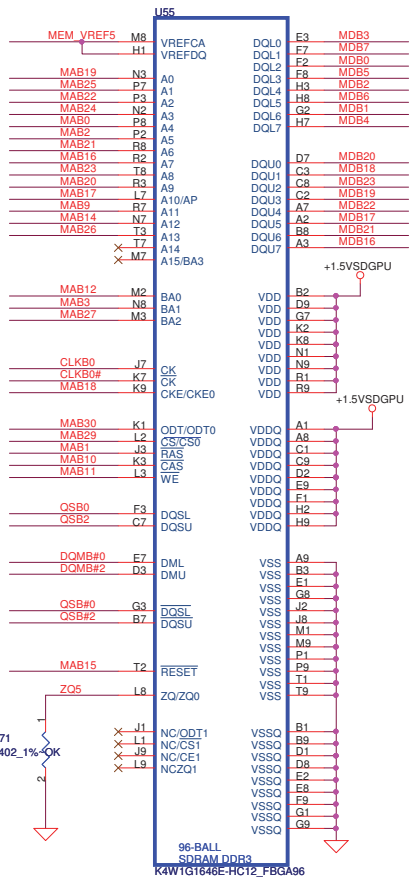
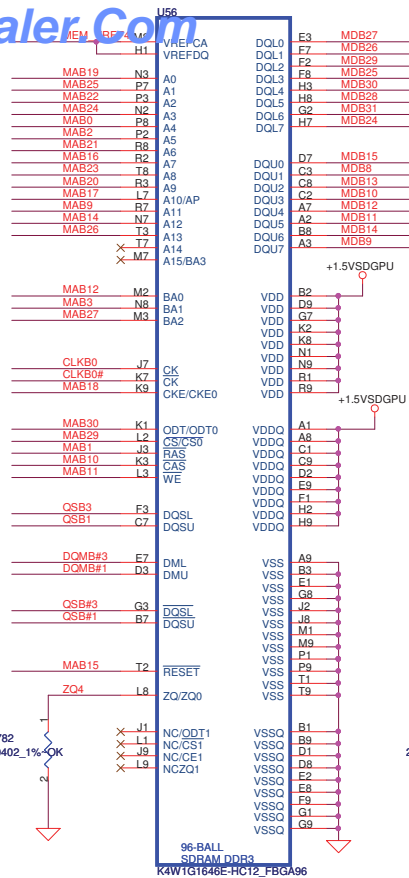
**Must be used 1% resistor for driver calibration**

***Compal Electronics, Inc.***

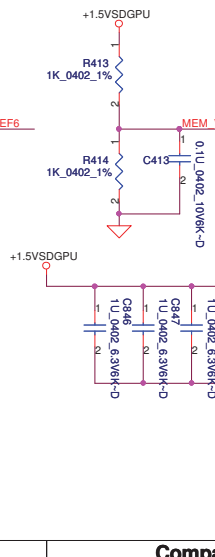
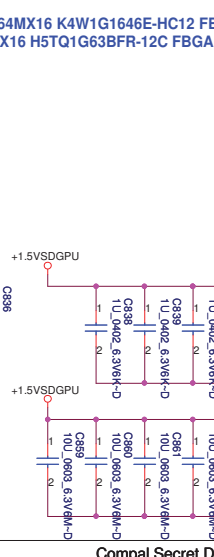
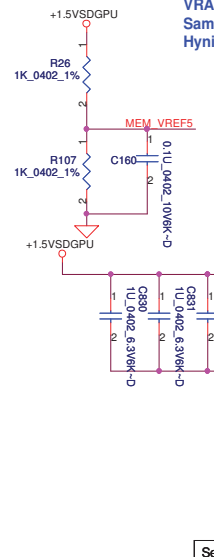
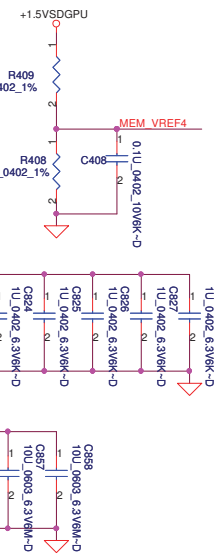
### ***N11P-GS1(5/5) MEMORY***

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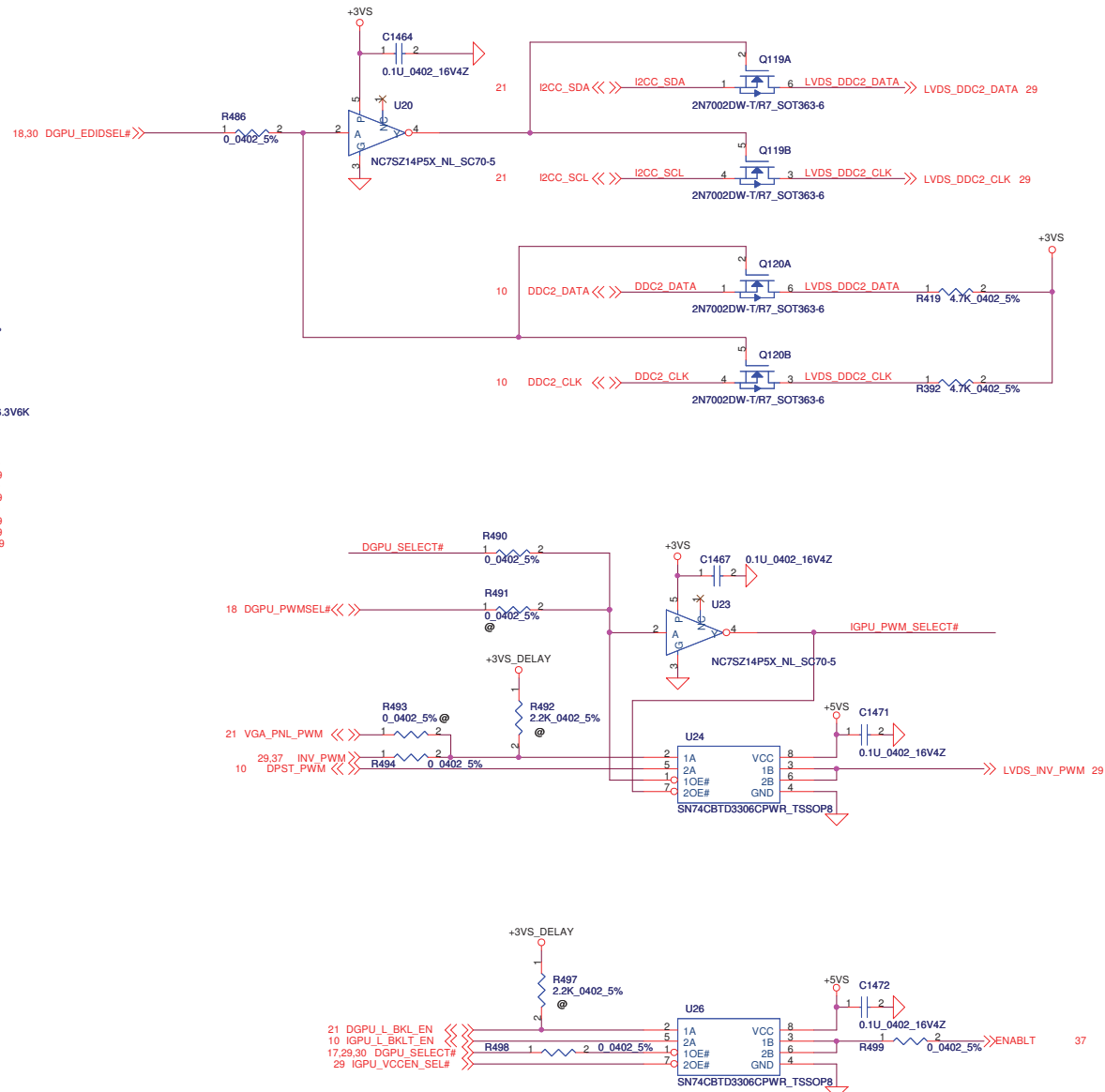
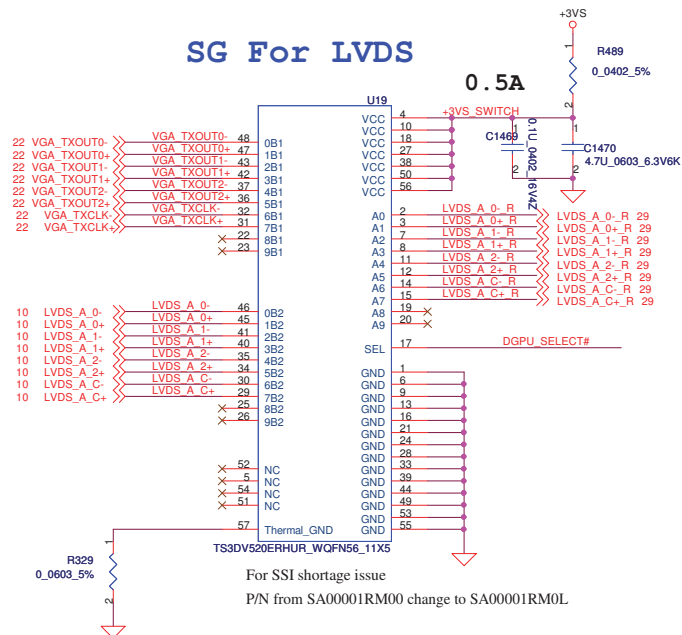


MAB7	R219	1	2	10K 0402 5%
MAB18	R110	1	2	10K 0402 5%
MAB28	R265	1	2	10K 0402 5%
MAB30	R232	1	2	10K 0402 5%
MAB15	R266	1	2	10K 0402 5%



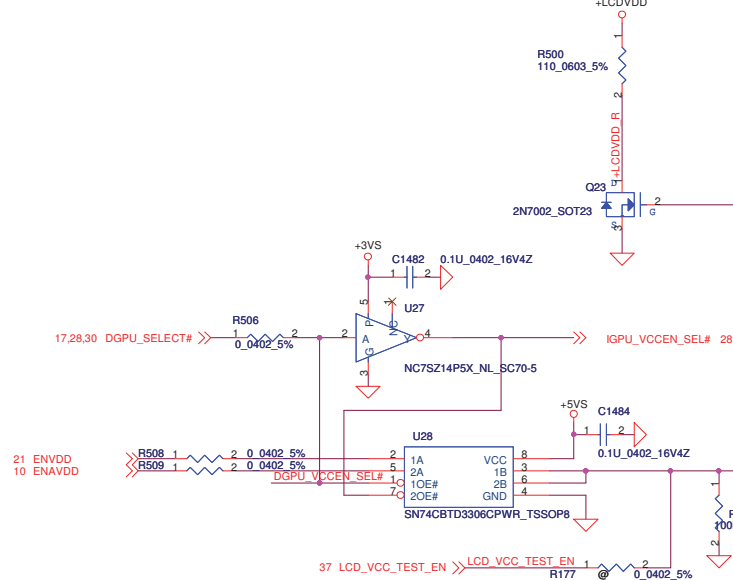
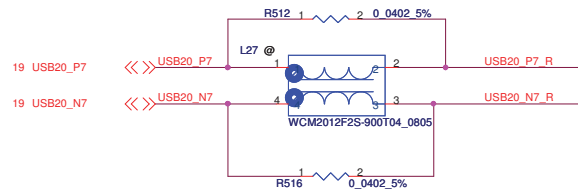
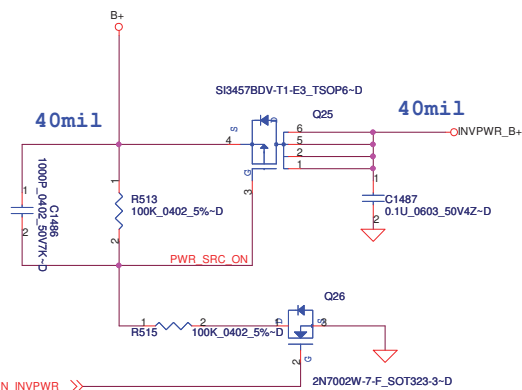
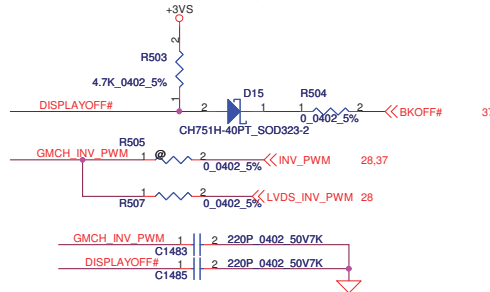
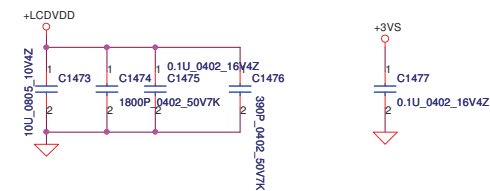
VRAM P/N :  
 Samsung : SA000035700 (S IC D3 64MX16 K4W1G1646E-HC12 FBGA 96P)  
 Hynix : SA000032400 (S IC D3 64MX16 H5TG1G63BFR-12C FBGA 1.5V)

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Size		Document Number		Customer		LA-5811P		Date		Rev	
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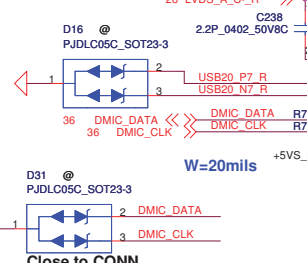
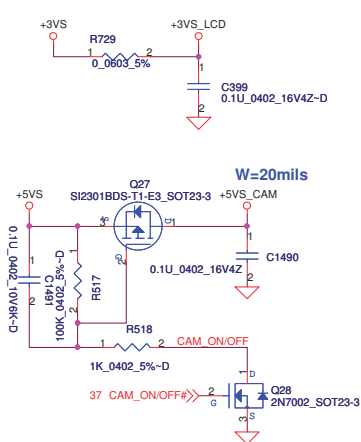
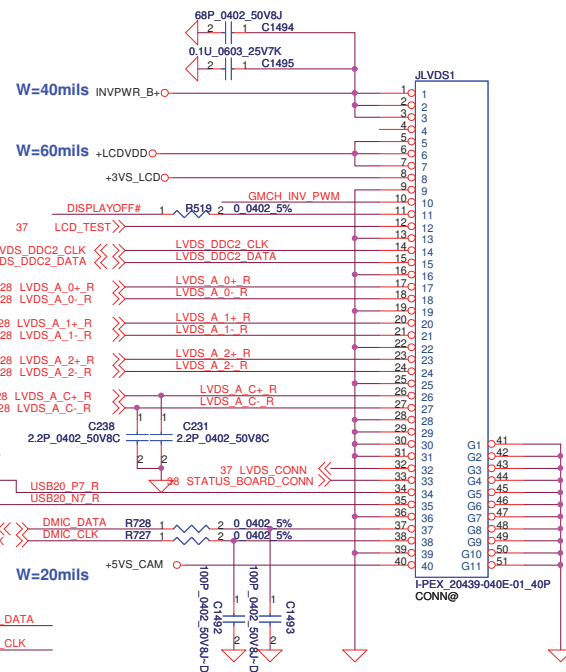


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Size	Document Number	Rev		Date	
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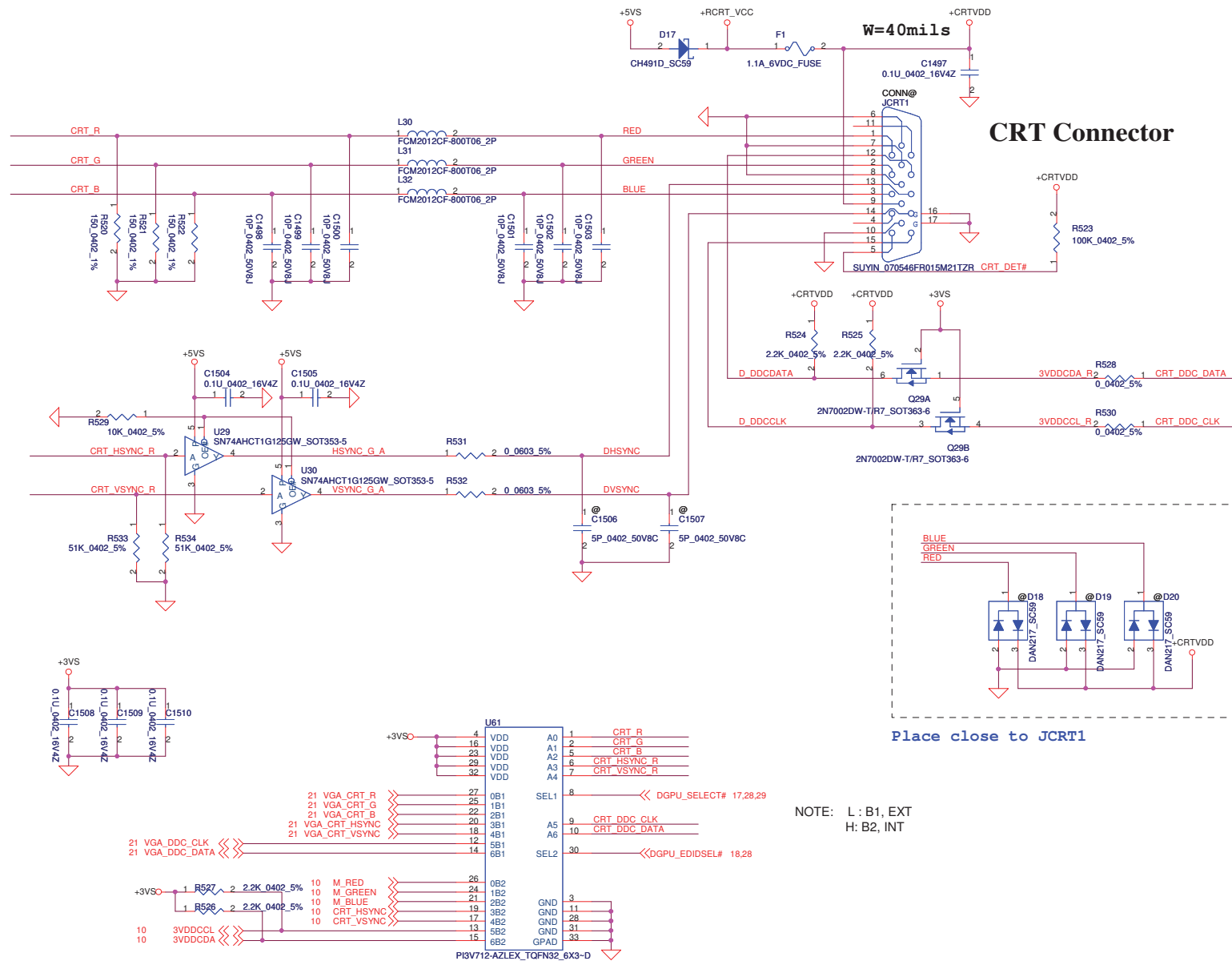


### LVDS and USB CAM connector

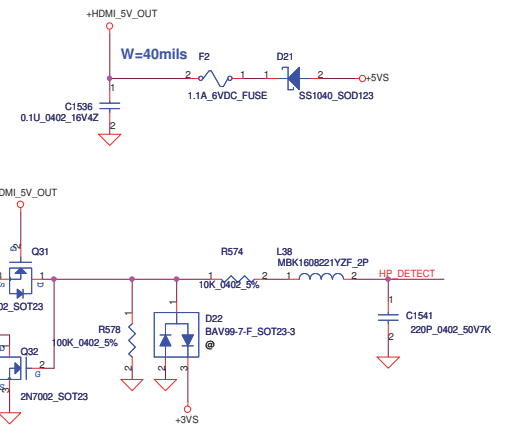


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				Rev	1.0
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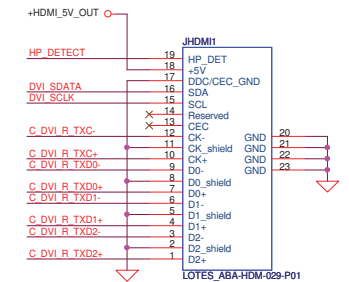
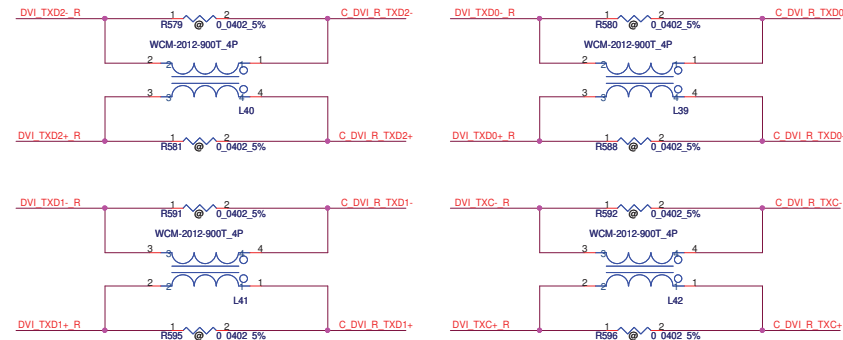




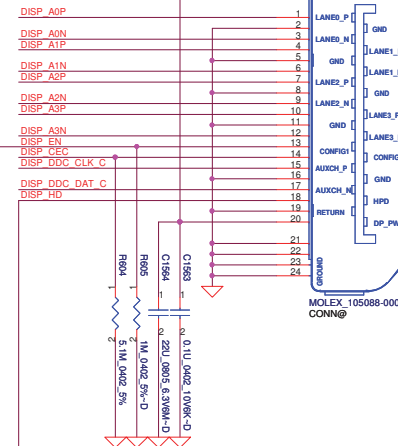
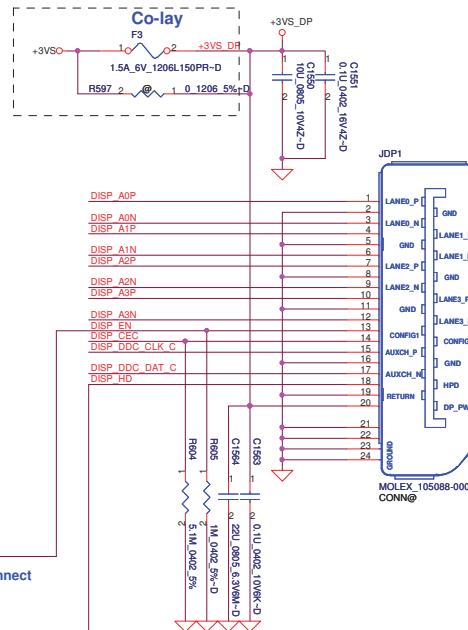
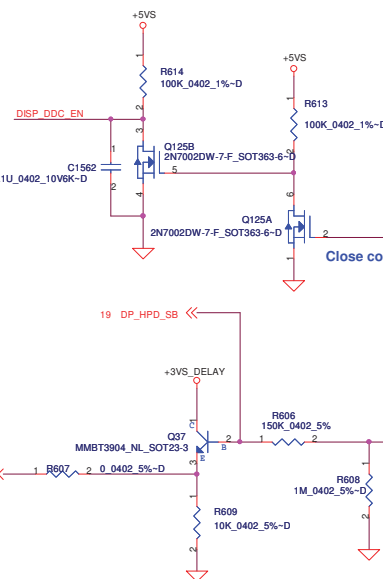
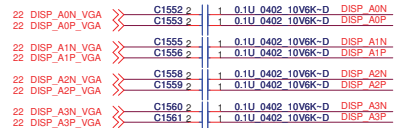
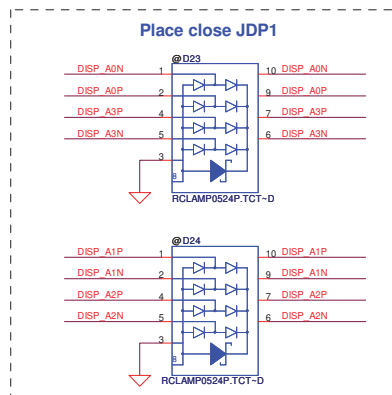
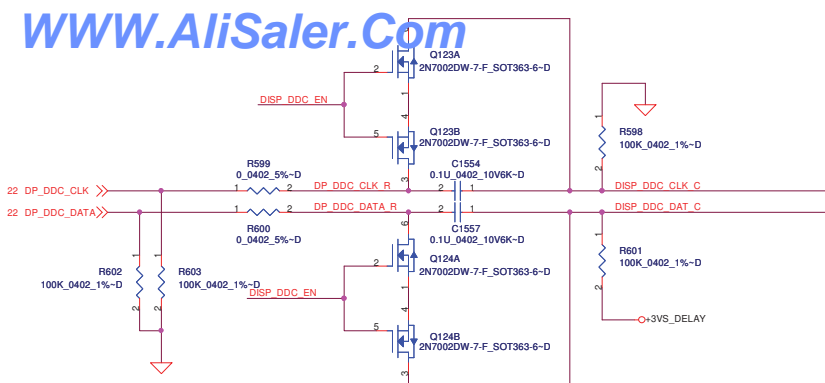
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Issued Date	2009/07/25	Deciphered Date	2010/07/25	Title	
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Size	Document Number	Rev		1.0	
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Sheet		30		of 58	



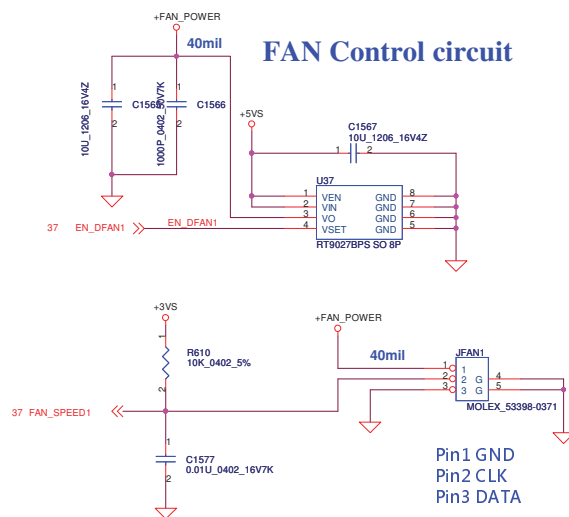
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22	VGA_DVI_TXD2+	VGA DVI TXD2+	C1543	2	1 0.1U 0402 16V7K	DVI TXD2+ R
22	VGA_DVI_TXD1+	VGA DVI TXD1+	C1544	2	1 0.1U 0402 16V7K	DVI TXD1+ R
22	VGA_DVI_TXD1+	VGA DVI TXD1+	C1545	2	1 0.1U 0402 16V7K	DVI TXD1+ R
22	VGA_DVI_TXD0+	VGA DVI TXD0+	C1546	2	1 0.1U 0402 16V7K	DVI TXD0+ R
22	VGA_DVI_TXD0+	VGA DVI TXD0+	C1547	2	1 0.1U 0402 16V7K	DVI TXD0+ R
22	VGA_DVI_TXC+	VGA DVI TXC+	C1548	2	1 0.1U 0402 16V7K	DVI TXC+ R
22	VGA_DVI_TXC+	VGA DVI TXC+	C1549	2	1 0.1U 0402 16V7K	DVI TXC+ R



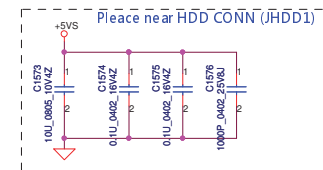
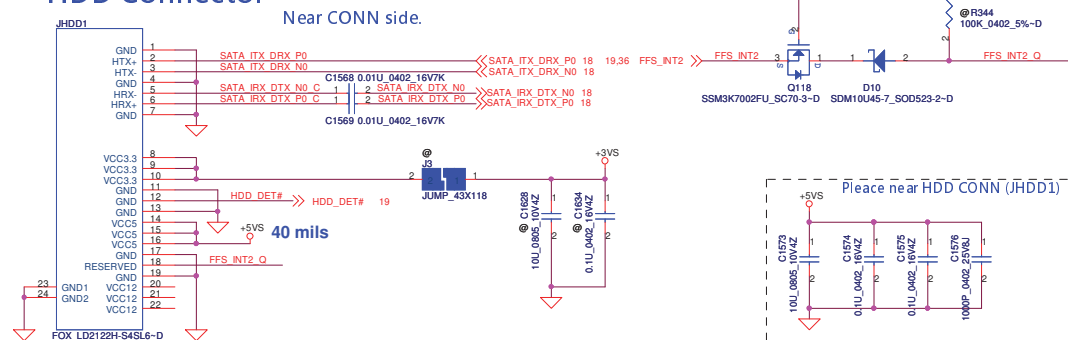
**WWW.AliSaler.Com**



## FAN Control circuit

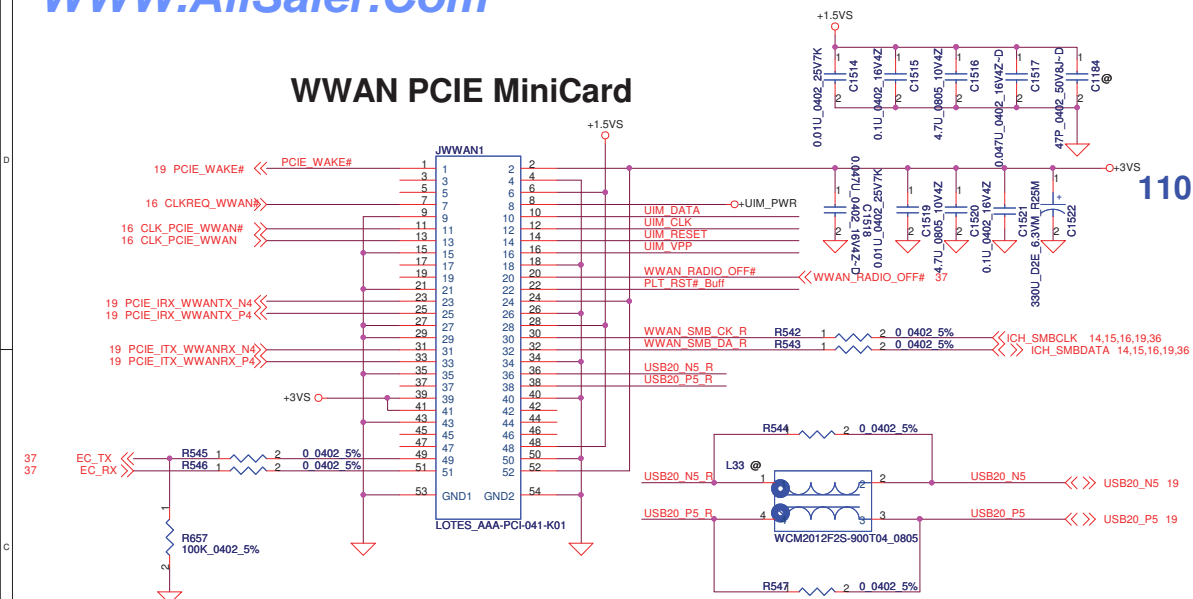


## HDD Connector

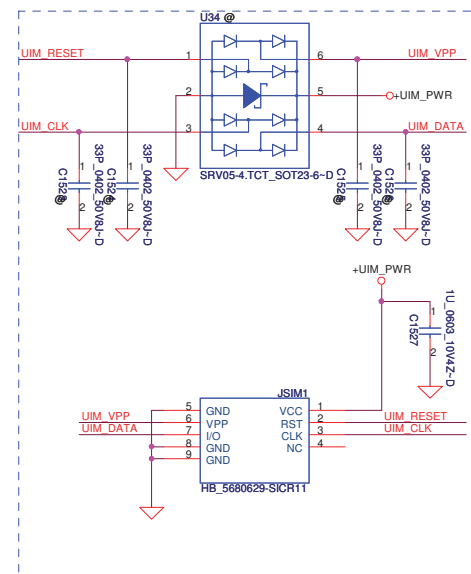


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				Date:	Tuesday, December 29, 2009	Sheet 32 of 58

## WWAN PCIE MiniCard

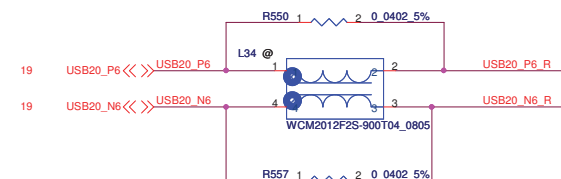
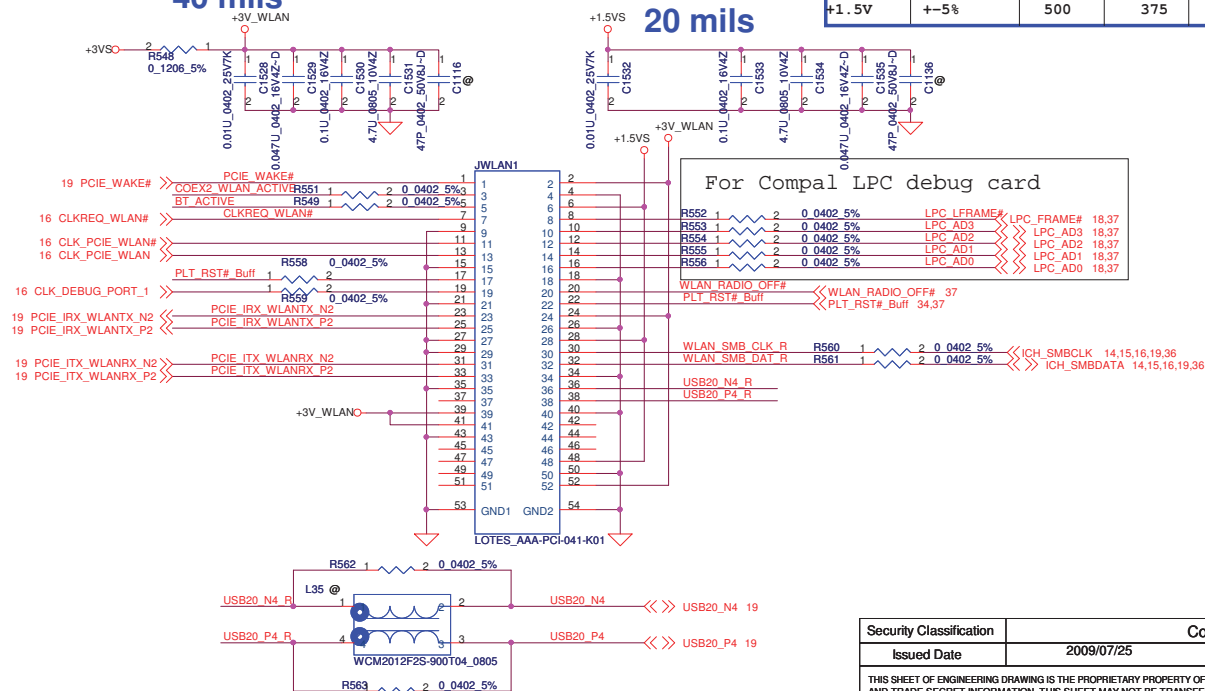


## SIM Card

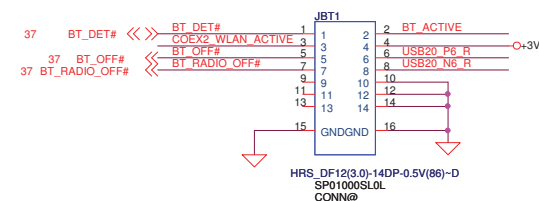


PWR Rail	Voltage Tolerance	Primary Power		Aux Power
		Peak	Normal	Normal
+3.3V	+−9%	1000	750	
+3.3Vaux	+−9%	330	250	250 (Wake enable) 5 (Not wake enable)
+1.5V	+−5%	500	375	NA

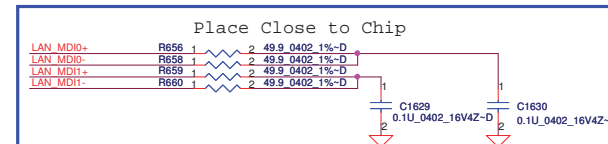
**40 mils** **WLAN/WIMAX PCIE Mini Card** **20 mils**  
+3V\_WLAN +1.5VS



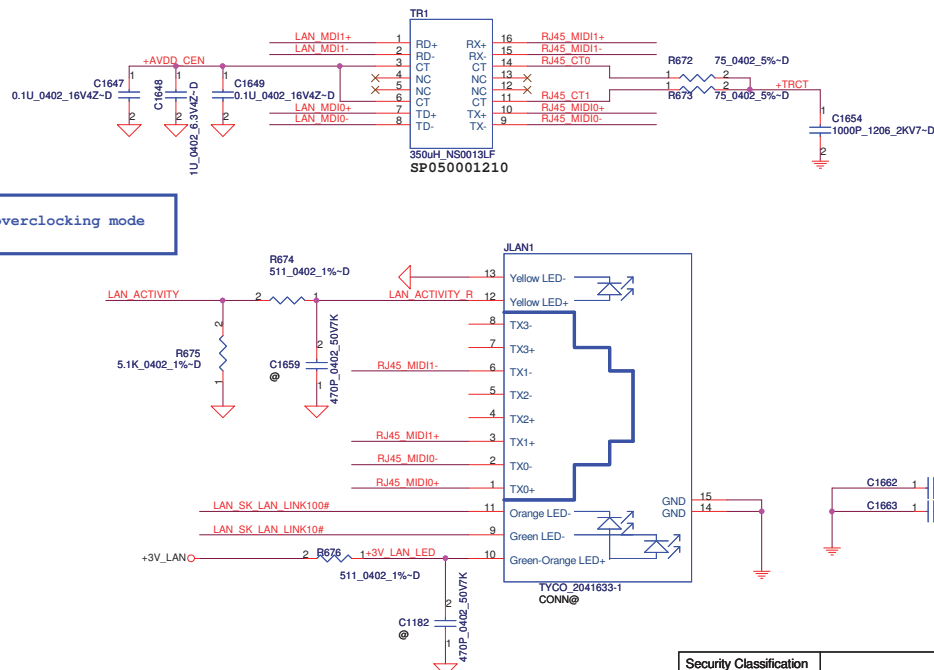
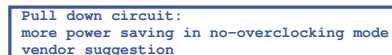
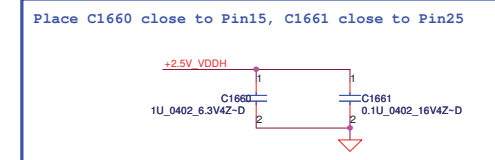
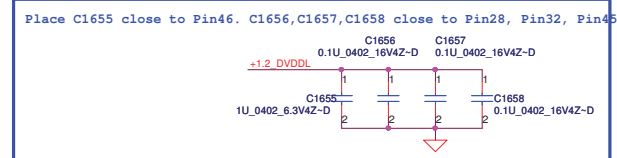
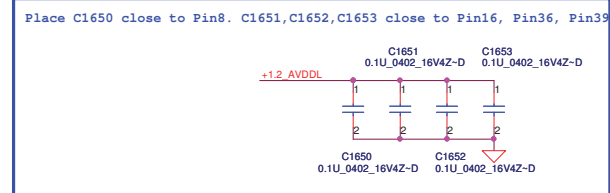
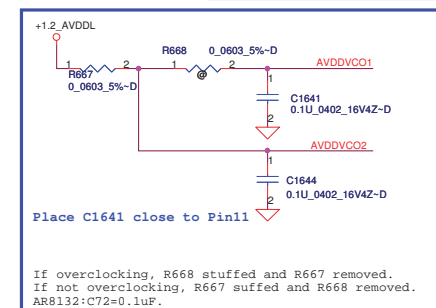
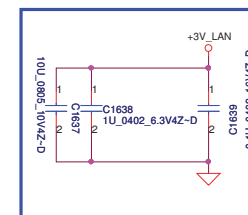
## Bluetooth

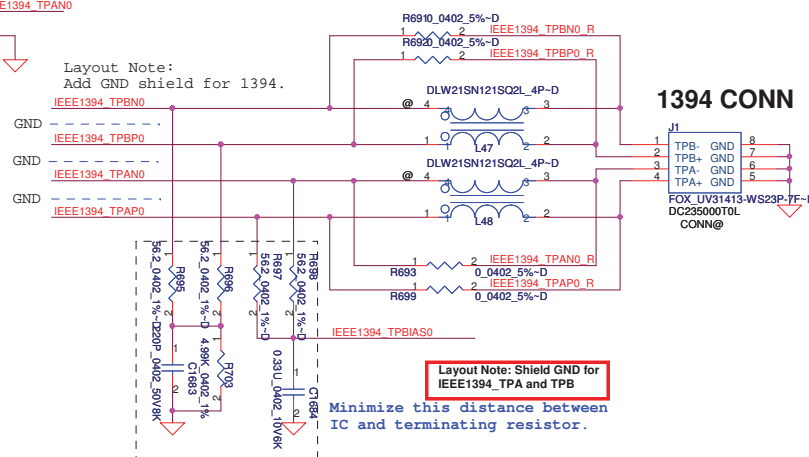
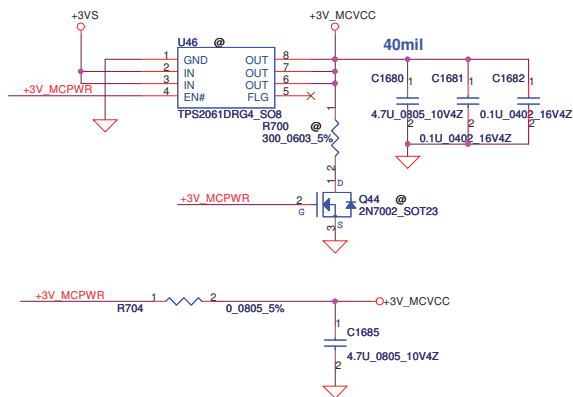
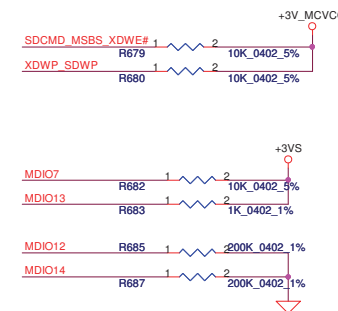
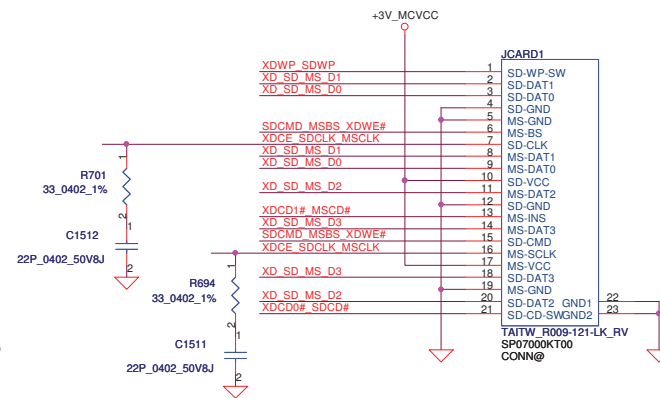
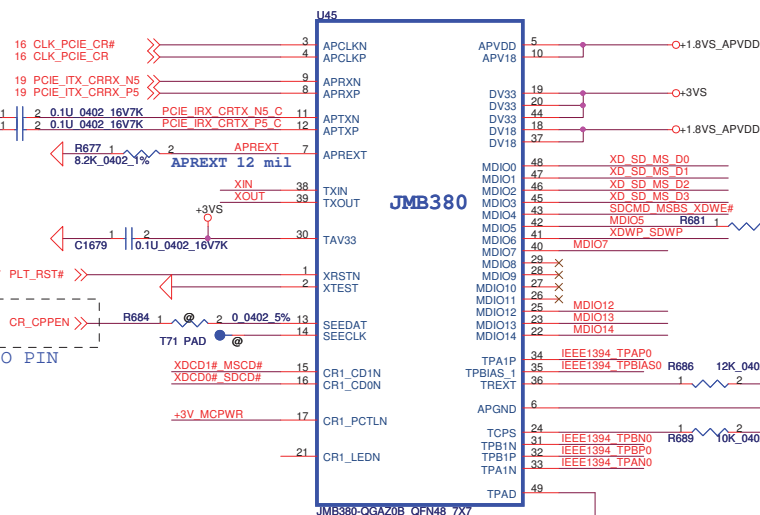
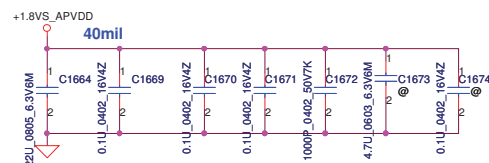


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				Date:	Tuesday, December 29, 2009 Sheet 33 of 58



**Layout Notice :** Place as close chip as possible.

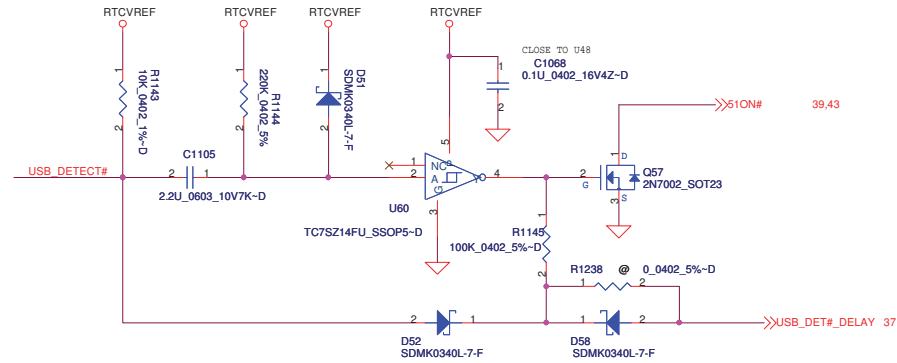
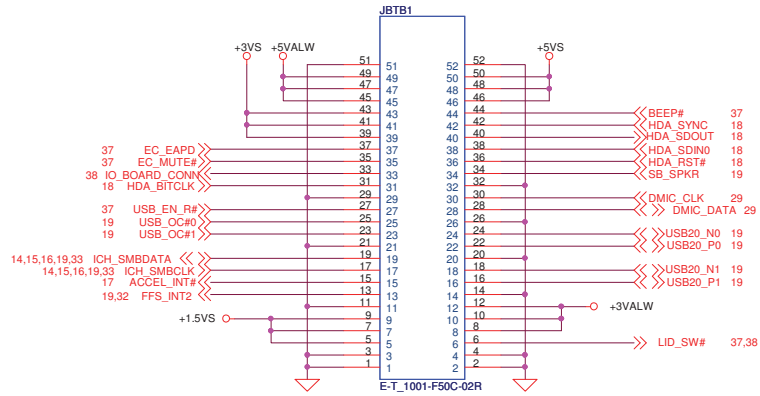




DELL CONFIDENTIAL/PROPRIETARY

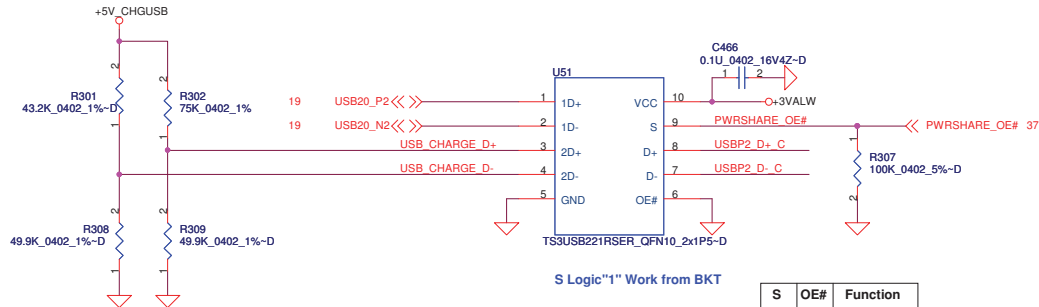
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				Date:	Tuesday, December 29, 2009
				Sheet	35 of 58

# IO Board CONN



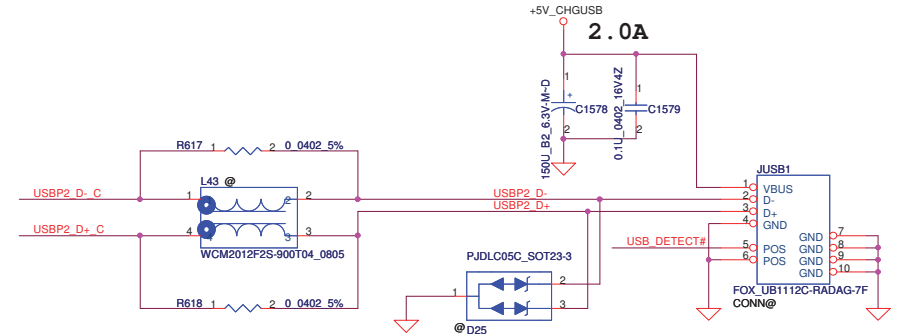
## Power share

fix +3VALW leakage on Batt mode

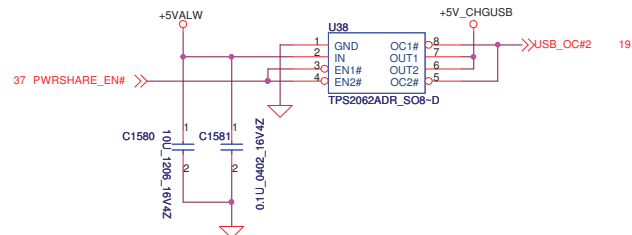


S Logic "1" Work from BKT

S	OE#	Function
X	H	Disconnect
L	L	D=1D
H	L	D=2D



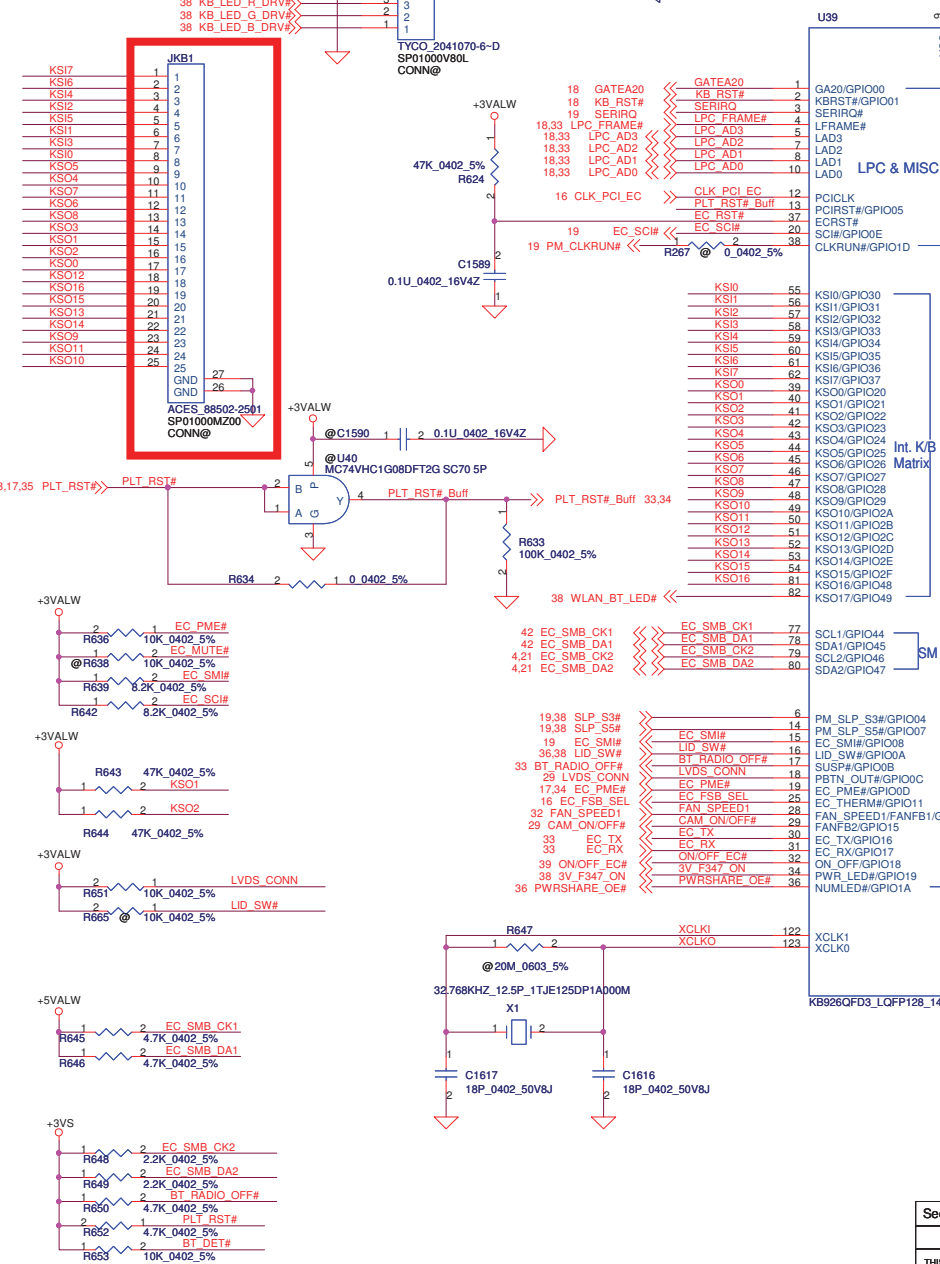
## 2.0A



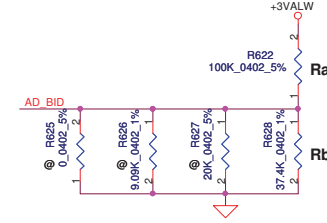
Security Classification		Compal Secret Data		Title	
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Size	Document Number	Rev		1.0	
Custom	LA-5811P	Date		Tuesday, December 29, 2009	
Sheet		36		of 58	



# KEYBOARD CONN.



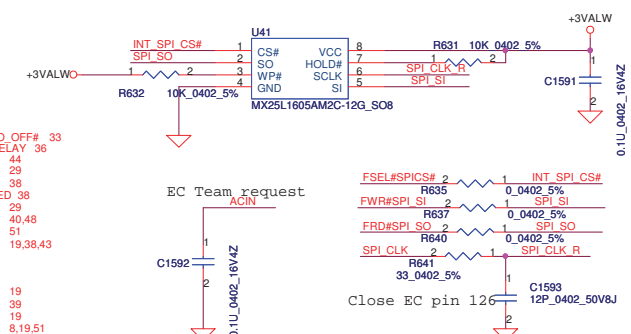
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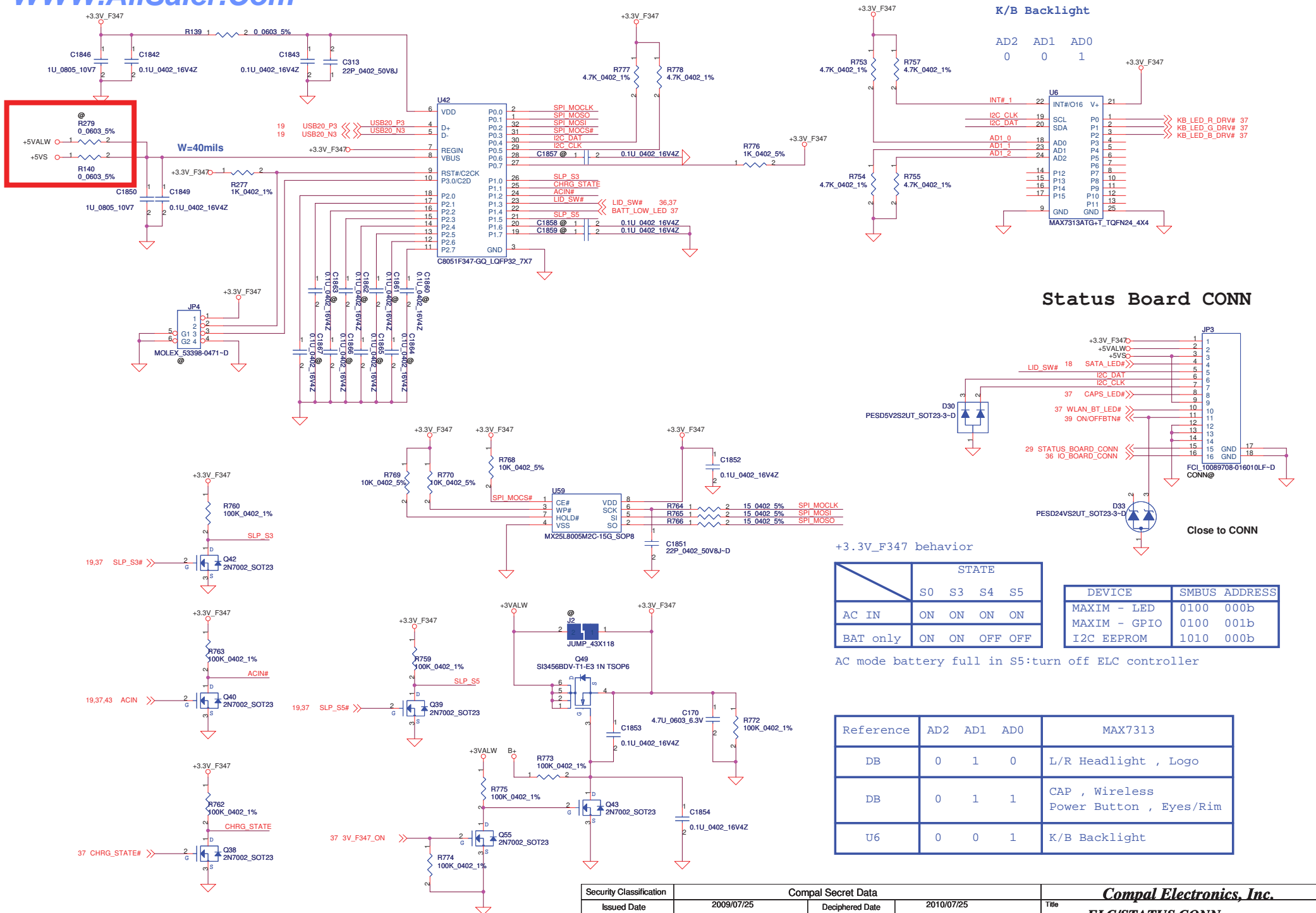
## BOARD ID Table

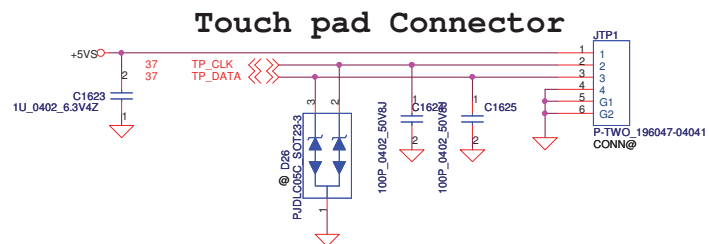
ID	BOARD ID	Ra	Rb	Vab
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1	0.2(X01)	100K	9.09K	0.25V
2	0.3(X02)	100K	20K	0.50V
3	1.0(A00)	100K	37.4K	0.82V

# System SPI Flash ROM (16Mb)

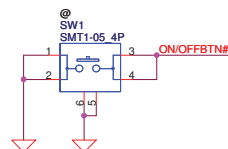


Component	Value	Component	Value
KSO8	@C1594	100P 0402 25V8K	C1594
KSI3	@C1596	100P 0402 25V8K	C1596
KSO9	@C1598	100P 0402 25V8K	C1598
KSI2	@C1600	100P 0402 25V8K	C1600
KSI1	@C1602	100P 0402 25V8K	C1602
KSO10	@C1604	100P 0402 25V8K	C1604
KSO11	@C1608	100P 0402 25V8K	C1608
KSI0	@C1611	100P 0402 25V8K	C1611
KSO12	@C1612	100P 0402 25V8K	C1612
KSO13	@C1614	100P 0402 25V8K	C1614
KSO14	@C1618	100P 0402 25V8K	C1618
KSO15	@C1620	100P 0402 25V8K	C1620
KSO16	@C1622	100P 0402 25V8K	C1622

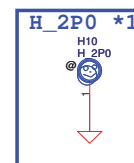
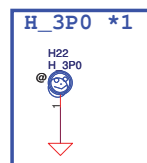
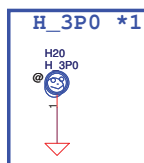
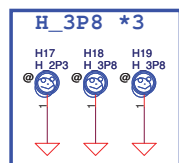
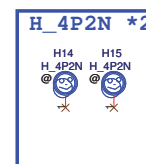
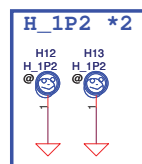
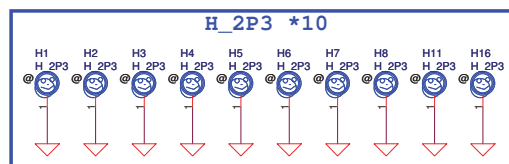
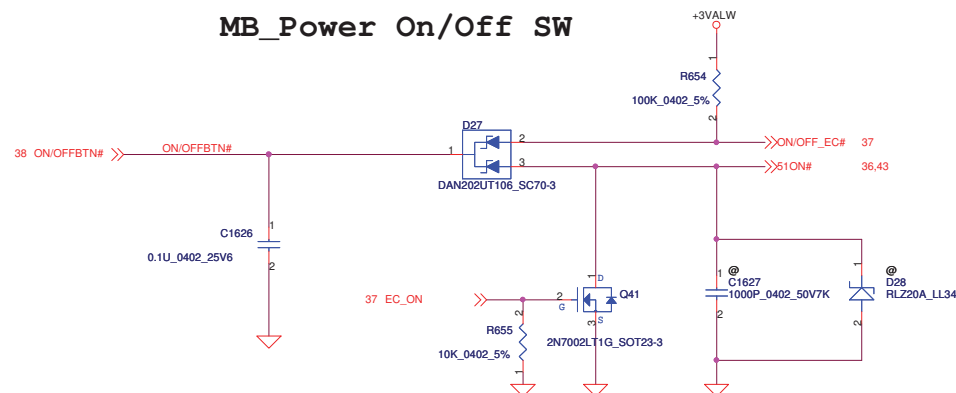




For Debug Only

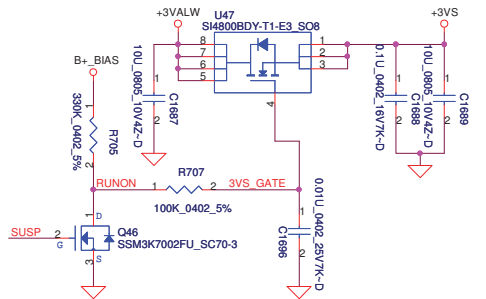


### MB\_Power On/Off SW

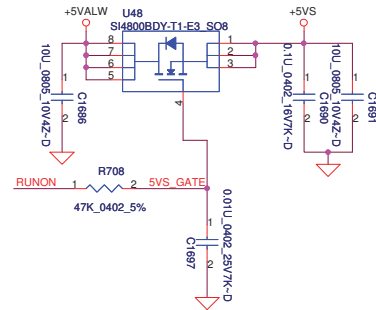


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				Size Custom	Document Number LA-5811P
Date: Tuesday, December 29, 2009				Sheet 39 of 58	Rev 1.0

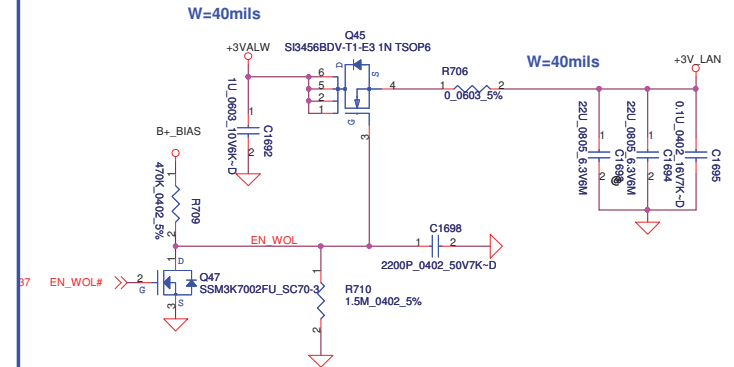
# +3VALW to +3VS Transfer



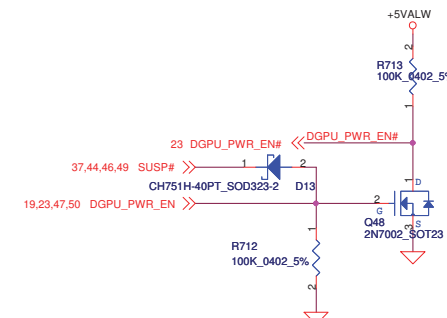
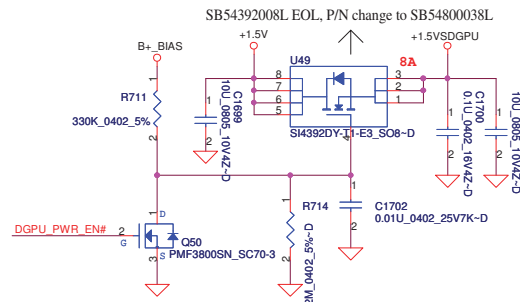
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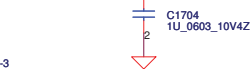
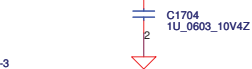
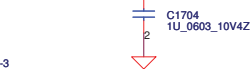
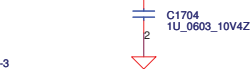
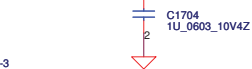
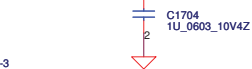
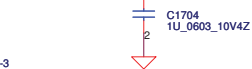
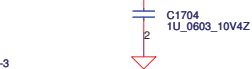
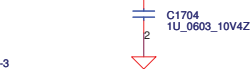
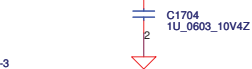
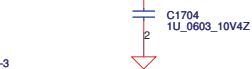
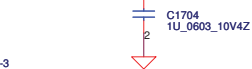
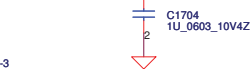
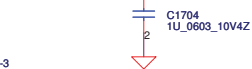
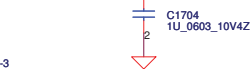
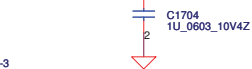
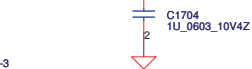
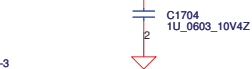
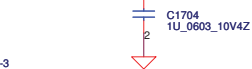
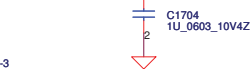
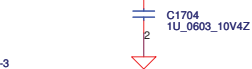
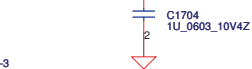
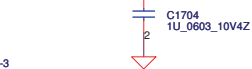
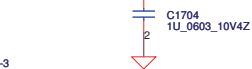
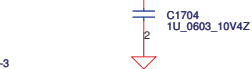
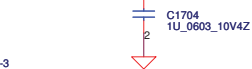
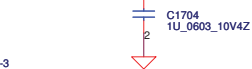
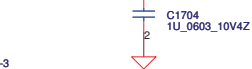
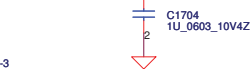
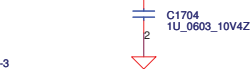
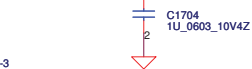
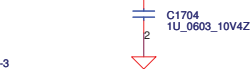
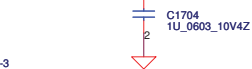
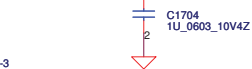
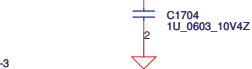
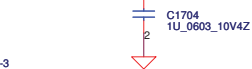
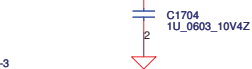
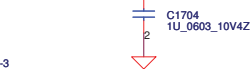
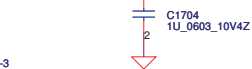
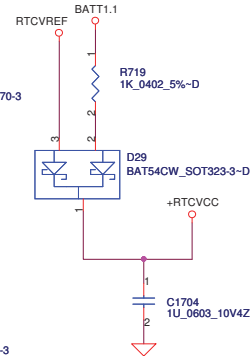
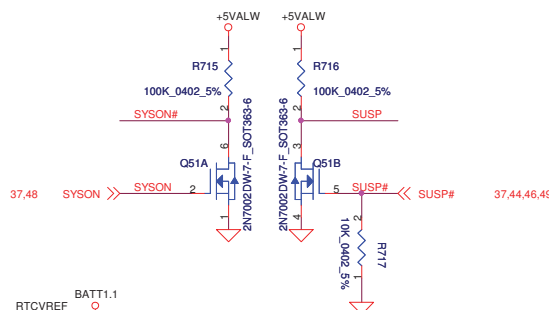
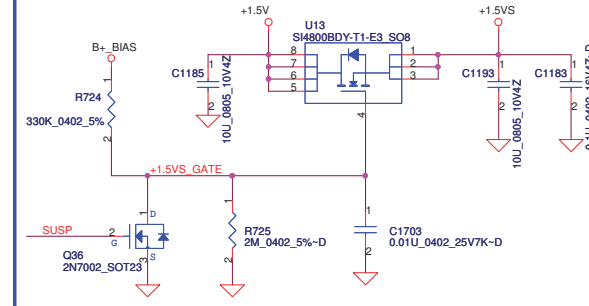
# +3VALW to +3LAN Transfer



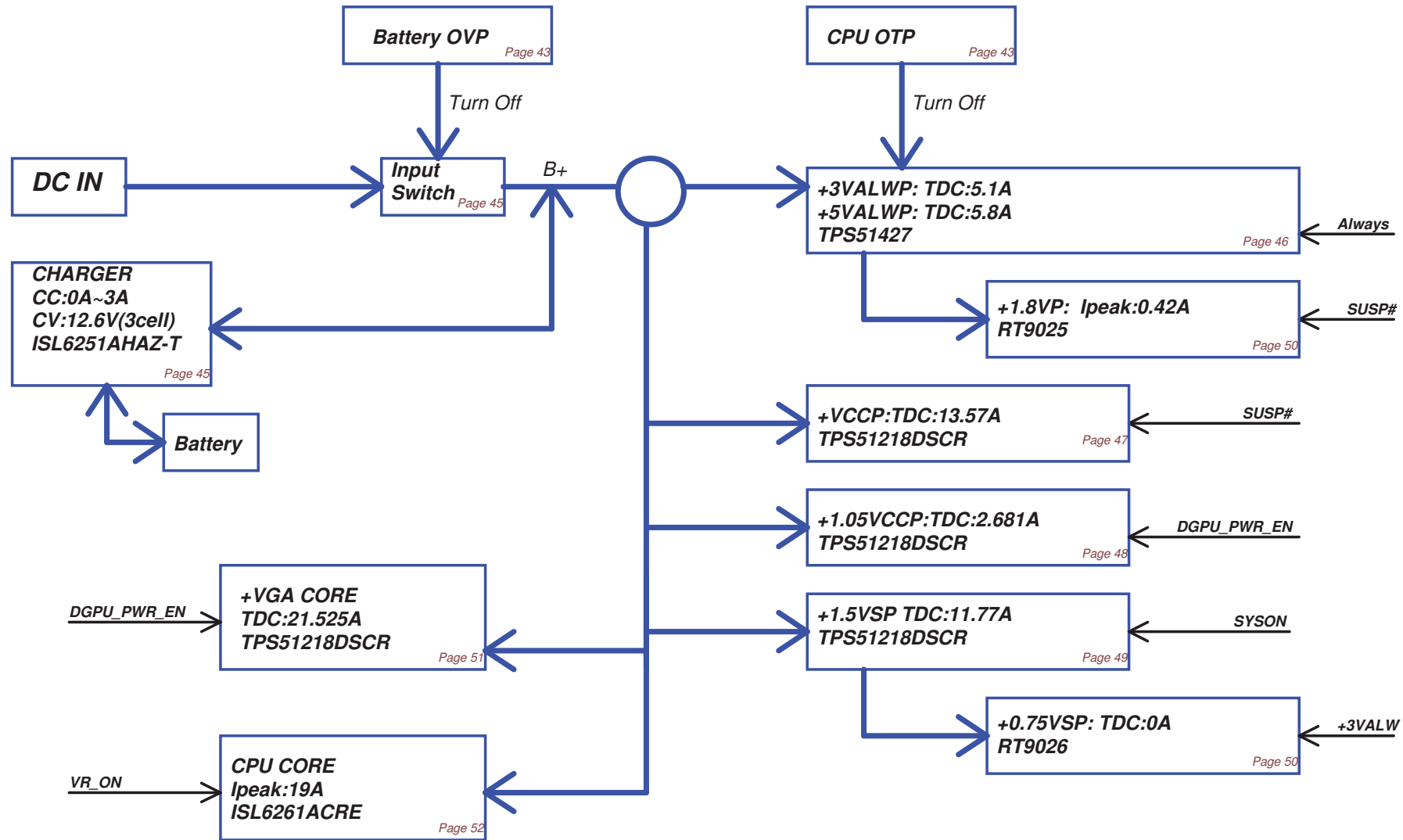
# +1.5V to +1.5VSDGPU Transfer



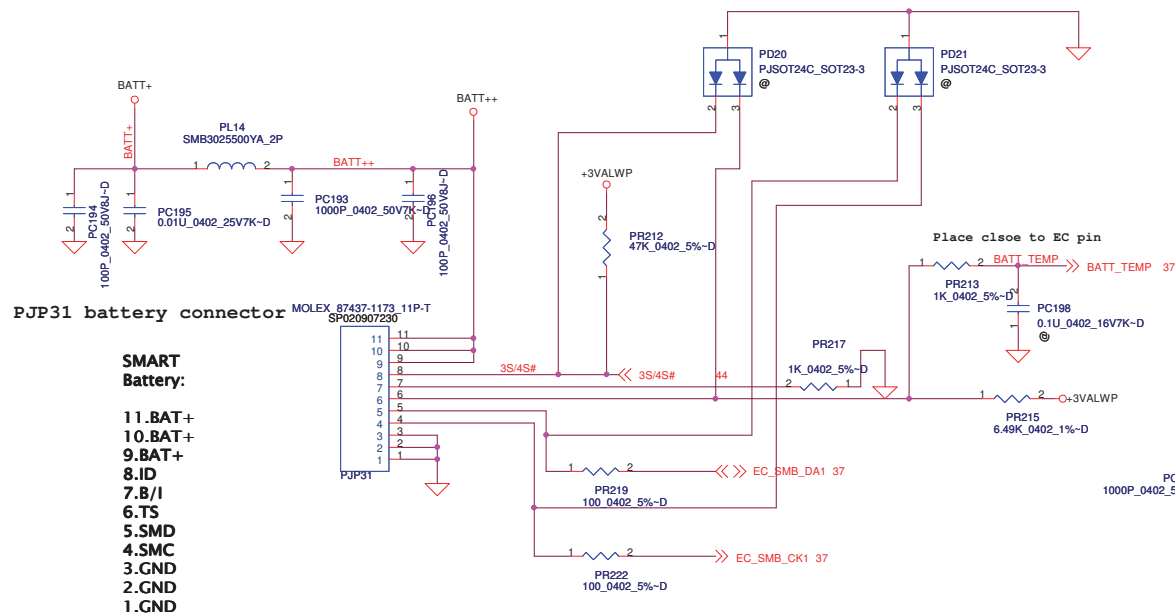
# +1.5V to +1.5VS Transfer



# Power block

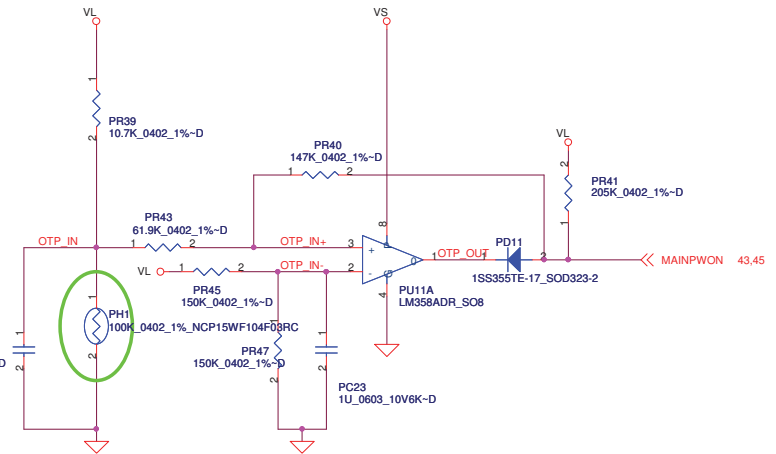


Title		
POWER BLOCK DIAGRAM		
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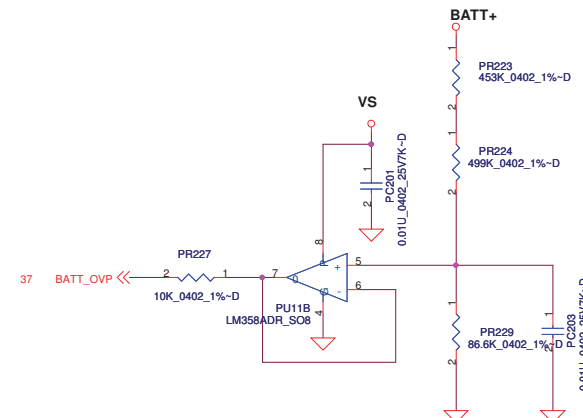
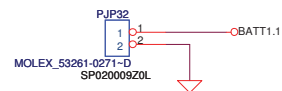


## CPU OTP

**PH1 under CPU botten side :**  
CPU thermal protection at 90 +-3 degree C  
Recovery at 50 +-3 degree C



## COIN RTC Battery



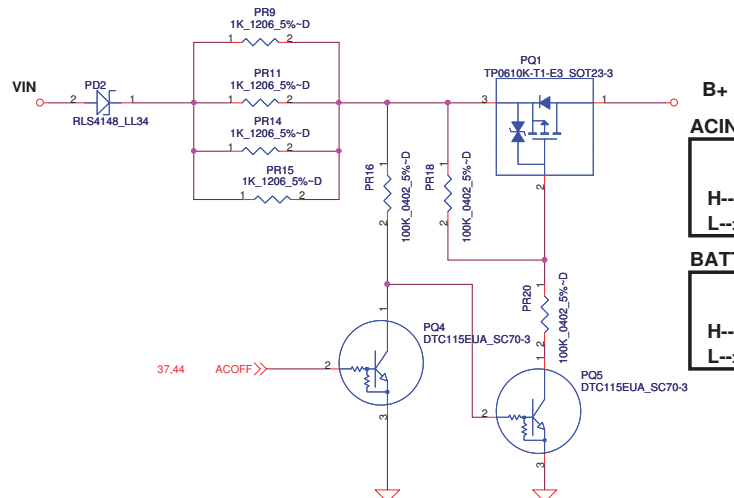
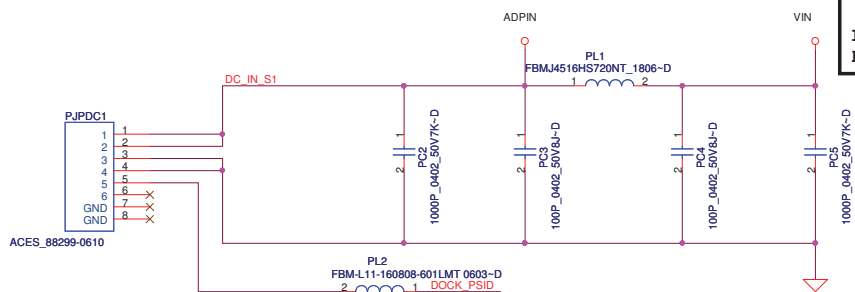
**LI-3S : 13.5V----**BATT-OVP=1.126V  
**LI-4S : 18V----**BATT-OVP=1.5V  
**BATT-OVP=0.08338\*BATT+**

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### Vin Detector

	Max.	typ.	Min.
L-->H	18.234	17.841	17.449
H-->L	17.597	17.210	16.813



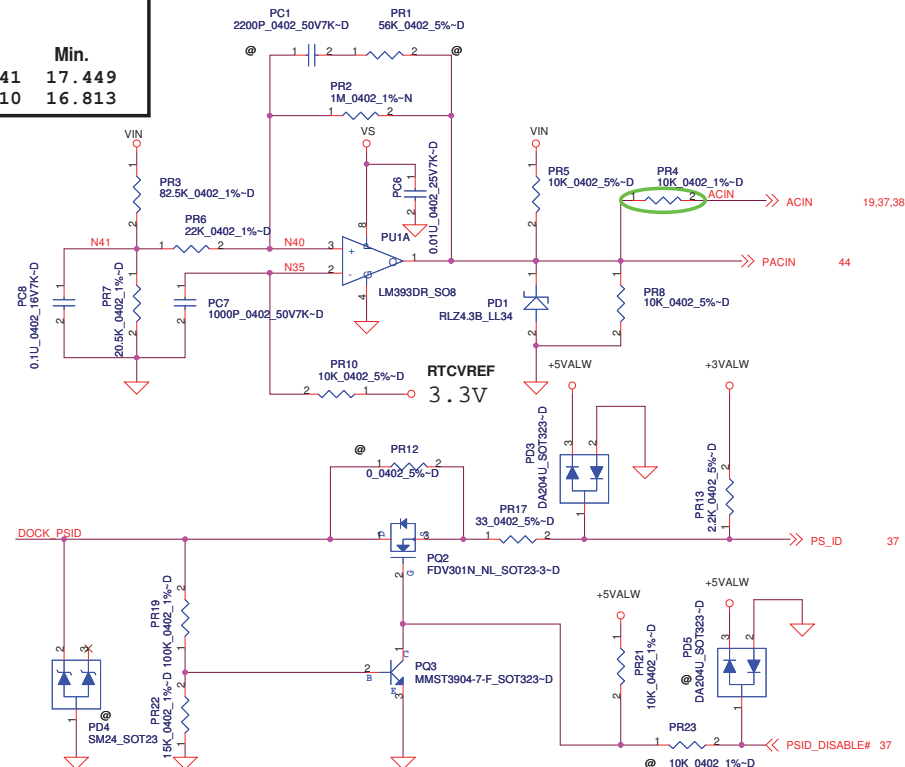
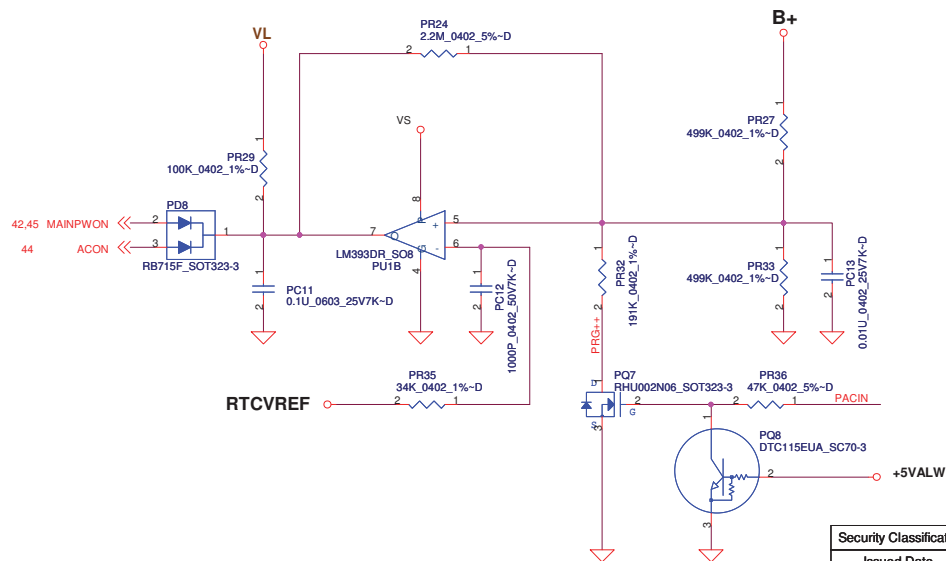
B+

ACIN

	Min.	typ.	Max.
H-->L	14.589V	14.84V	15.243V
L-->H	15.562V	15.97V	16.388V

BATT ONLY

	Min.	typ.	Max.
H-->L	6.138V	6.214V	6.359V
L-->H	7.196V	7.349V	7.505V



BATT+

CHGRTPC

36.39 51ON#

VS

RTCVREF

MAX1615 IN

MAX1615 #SHDN1

MAX1615EUK+\_SOT23-5-D

MAX1615 IN

MAX1615 #SHDN1

MAX1615EUK+\_SOT23-5-D

MAX1615 IN

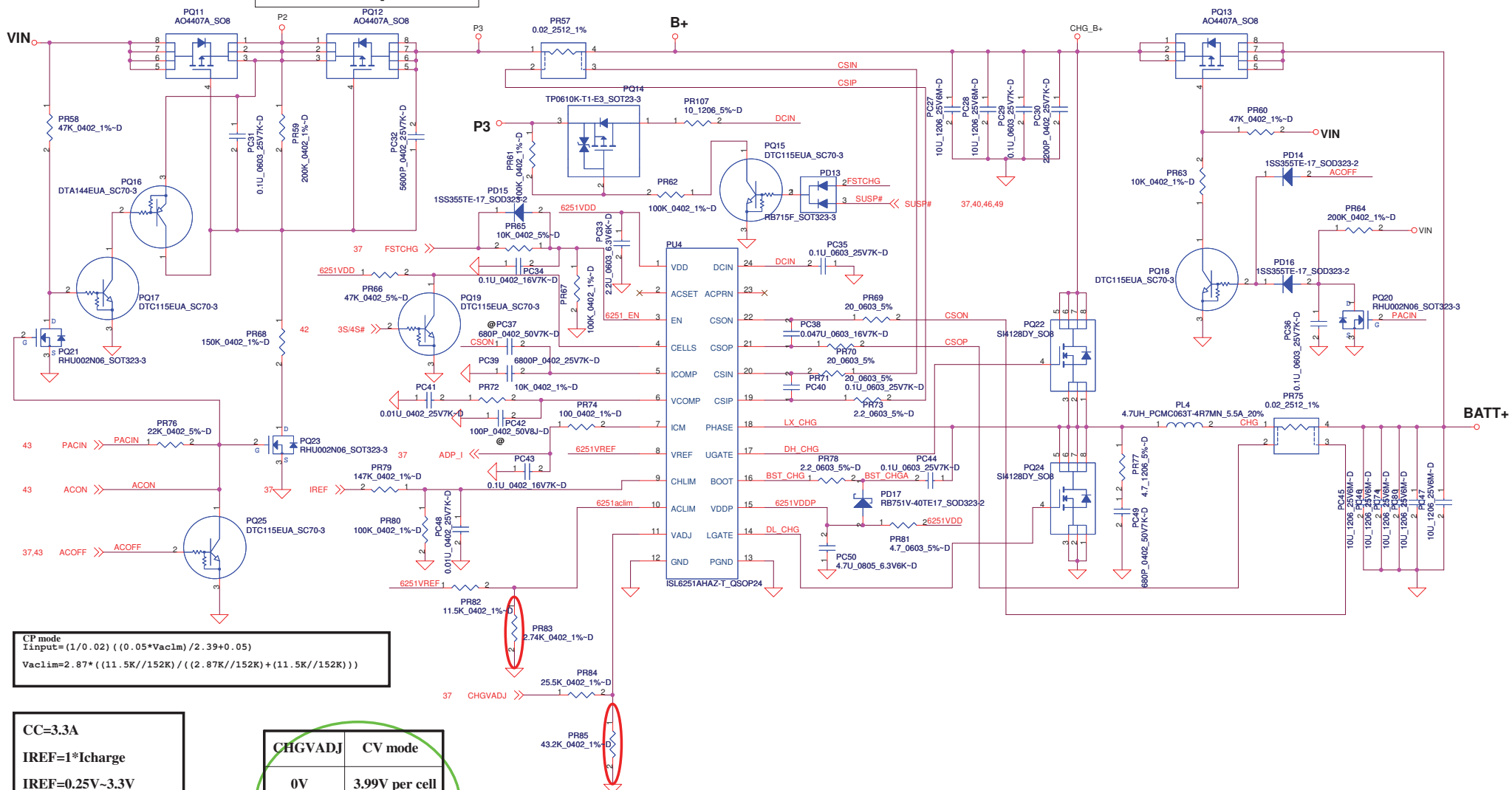
MAX1615 #SHDN1

MAX1615EUK+\_SOT23-5-D

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				Size	Document Number	Rev
				Custom		
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Iada=0~3.333A(65W)

$$ADP\_I = 19.5 \cdot I_{\text{adapter}} \cdot R_{\text{sense}}$$



CP mode  
 $I_{\text{input}} = (1/0.02) \cdot ((0.05 \cdot V_{\text{aclim}}) / 2.39 + 0.05)$   
 $V_{\text{aclim}} = 2.87 \cdot ((11.5K / 152K) / ((2.87K / 152K) + (11.5K / 152K)))$

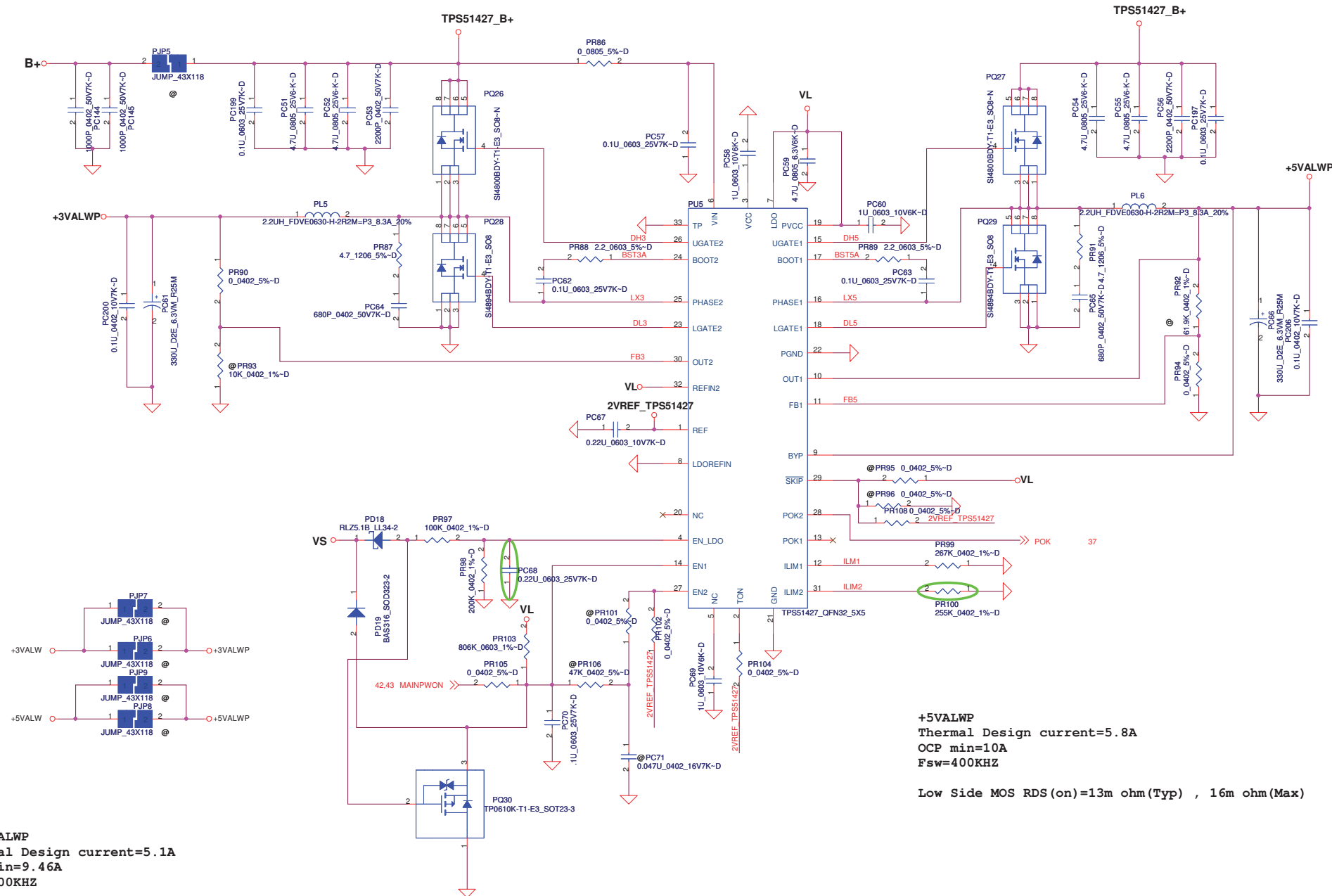
CC=3.3A  
 $I_{\text{REF}} = 1 \cdot I_{\text{charge}}$   
 $I_{\text{REF}} = 0.25V \sim 3.3V$

CHGVADJ	CV mode
0V	3.99V per cell
1.93V	4.2V per cell
3.3V	4.35V per cell

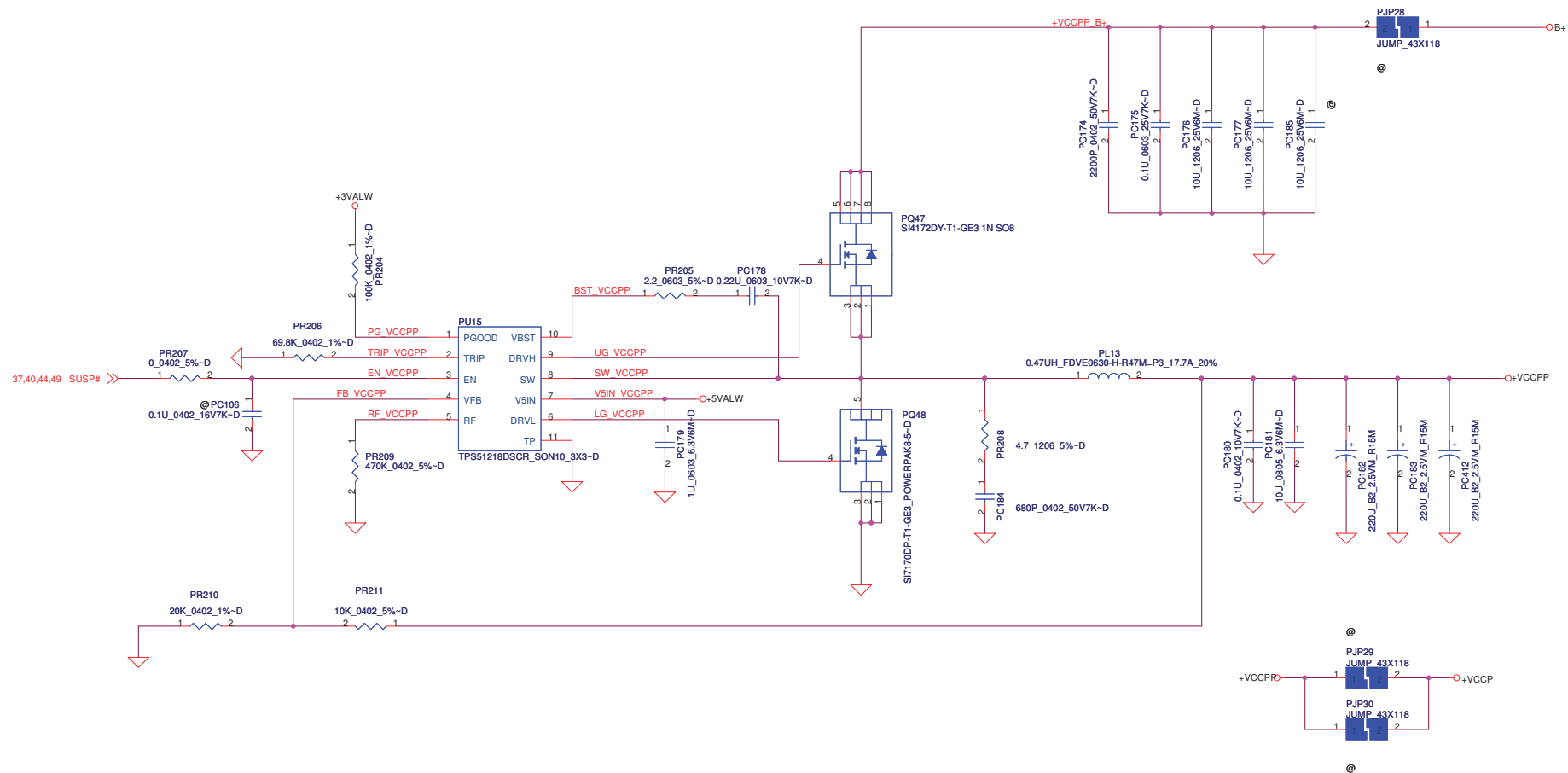
+3.3VALWP  
Thermal Design current=5.1A  
OCP min=9.46A  
Fsw=300KHZ

Low Side MOS RDS(on)=13m ohm(Typ) , 16m ohm(Max)

+5VALWP  
Thermal Design current=5.8A  
OCP min=10A  
Fsw=400KHZ  
  
Low Side MOS RDS(on)=13m ohm(Typ) , 16m ohm(Max)



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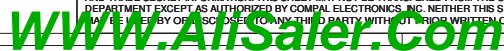
+VCCPP  
 Thermal Design current=13.57A  
 OCPmin=25.2A  
 Fsw=290KHZ

Low Side MOS RDS (on)=3.6m ohm(Typ) , 4.5m ohm(Max)

+VCCPP

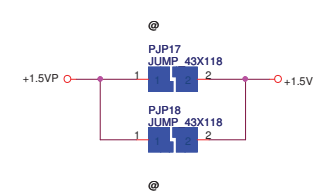
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Issued Date		Deciphered Date		Title	
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Low Side MOS RDS(on)=11.7m ohm(Typ) , 14.2m ohm(Max)



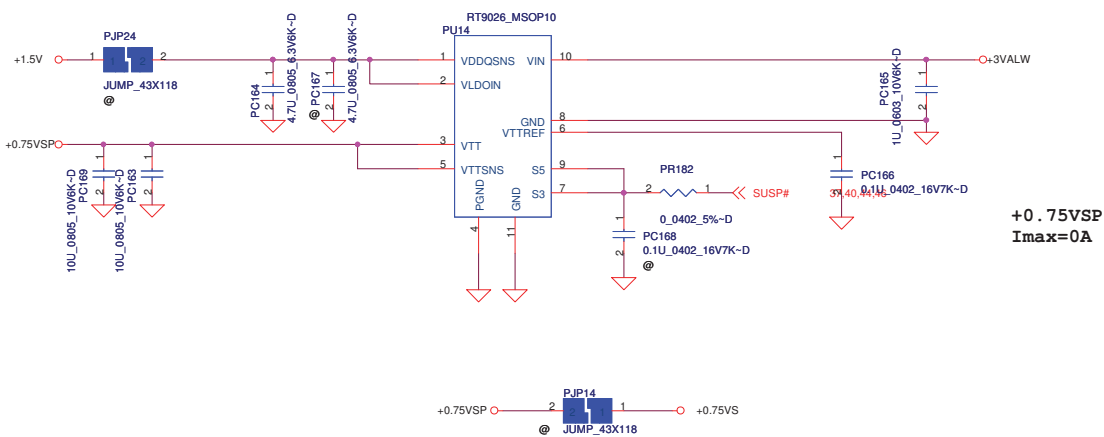
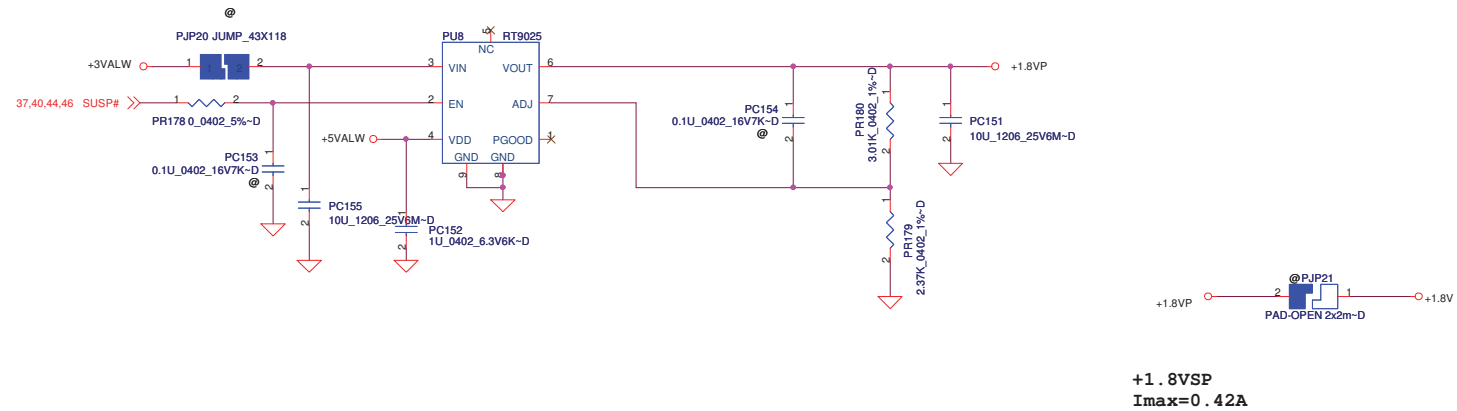
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Low Side MOS  $R_{DS(on)} = 3.6\text{m ohm (Typ)}$  ,  $4.5\text{m ohm (Max)}$



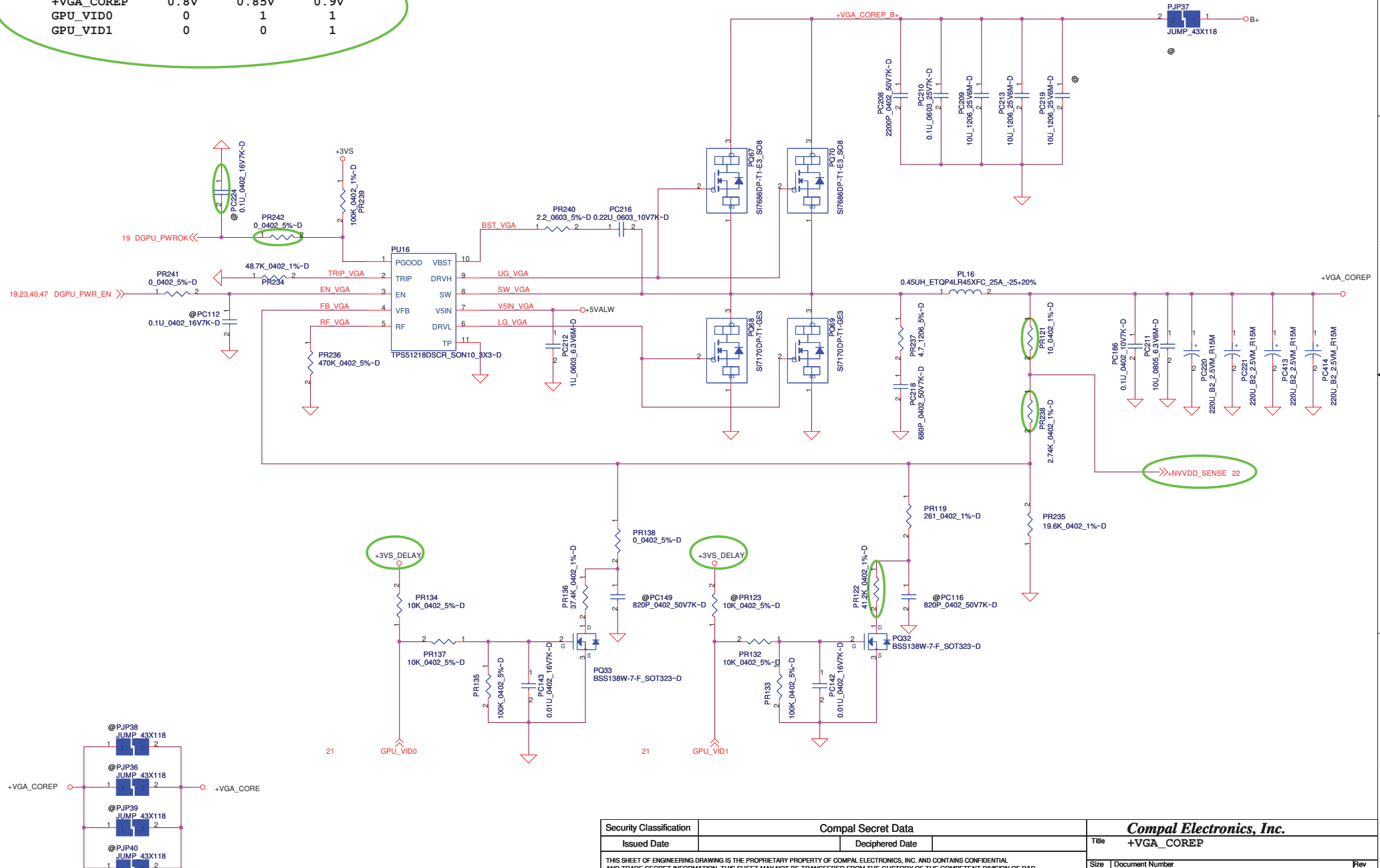
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Issued Date		Deciphered Date		Size: Document Number Custom:	
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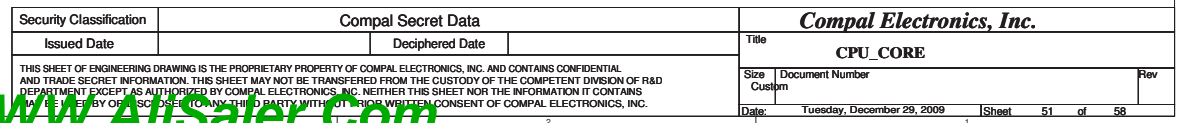


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+VGA_COREP	0.8V	0.85V	0.9V
GPU_VID0	0	1	1
GPU_VID1	0	0	1



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Item	Page#	Title	Date	Request Owner	Issue Description	Solution Description	Rev.
1	50	VGA_COREP	8/17	Antony	Change output voltage	Change PR119 from SD02800008L(0 ohm) to SD03426108L(261 ohm)	X00
2	50	VGA_COREP	8/17	Antony	Change output voltage	Change PR122 from SD03424928L(24.9K ohm) to SD03419128L(19.1K ohm)	X00
3	50	VGA_COREP	8/17	Antony	Change output voltage	Change PR136 from SD03437428L(37.4K ohm) to SD03440228L(40.2K ohm)	X00
4	50	VGA_COREP	8/17	Antony	Change output voltage	Change PR238 from SD00000AP8L(2.67K ohm) to SD03427418L(2.74K ohm)	X00
5	50	VGA_COREP	8/17	Antony	Output voltage setting 0.85V (NVIDIA request)	non-populate PR123(reserve space)	X00
6	44	CHARGER	9/10	Antony	CP point 90% setting	Change PR83 from 2.87K ohm to 2.74K ohm	X01
7	44	CHARGER	9/10	Antony	Charger voltage setting	Change PR85 from 200K ohm to 43.2K ohm	X01
8	48	+1.5VSP	9/16	Antony	EE required that SM_PWROK should change to +1.5V	Change net name PR124.1 from +3VALW to +1.5V	X01
9	50	VGA_COREP	9/16	Antony	Change VID time sequence	Change net name PR134.2 and PR123.2 from +3VS to +3VS_DELAY	X01
10	50	VGA_COREP	9/16	Antony	NVIDIA command	interchange with PR121 and PR238	X01
11	50	VGA_COREP	9/16	Antony	NVIDIA command	Delete PR139, +NVVDD_SENCE connect to PR121.2	X01
12	50	VGA_COREP	9/16	Antony	NVIDIA command	Change PR121 from 0 ohm to 10 ohm	X01
13	50	VGA_COREP	9/24	Antony	NVIDIA command	Change PR121 from 19.1K ohm to 41.2K ohm	X01
14	45	3VALWP/5VALWP	9/24	Antony	follow PSL component	Change PD19 from CH355PT to BAS316	X01
15	51	CPU_CORE	9/24	Antony	follow PSL component	Change PC127 to PSL component	X01

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Item	Page#	Title	Date	Request Owner	Issue Description	Solution Description	Rev.
16	46	+VCCPP	9/24	Antony	Change PN to 0 end	Change PQ48 from SB00000FO0L to SB00000FO00	X01
17	48	+1.5VP	9/24	Antony	Change PN to 0 end	Change PQ48 from SB00000FO0L to SB00000FO00	X01
18	50	VGA_COREP	10/1	Antony	EE required that PU16.1 pull high should change to +3VS	Change net name PR239.1 from +3VALW to +3VS	X01
19	48	+1.5VP	10/5	Antony	EMC request	Reserve PC223 space	X01
20	44	CHARGER	10/5	Antony	Quality enhancement	Reserve PQ22 from AO4466 to SI4128DY	X01
21	44	CHARGER	10/5	Antony	Quality enhancement	Reserve PQ24 from AO4466 to SI4128DY	X01
22	42	BATTERY_CONN/OTP	11/13	Antony	OTP meet setting	Change PH1 100K ohm thermistor	X02
23	43	DCIN/DETECTOR	11/13	Antony	Change component size	Change PC9 to size 0603	X03
24	45	+5VALWP/+3VALWP	11/13	Antony	Change component size	Change PC68 to size 0603	X03
25	45	+5VALWP/+3VALWP	11/13	Antony	The quality improvement suggests by PCP	Change PR100 to 255K ohm	X03
26	48	+1.5VSP	11/13	Antony	Reserve 0 ohm space	Add PR139 0 ohm resistor	X03
27	48	+1.5VSP	11/13	Antony	Change component size	Change PQ64 to SIS412DN	X03
28	50	VGA_COREP	11/13	Antony	Reserve RC space	Add PR242 0 ohm resistor and reserve PC223 space	X03
29	45	+5VALWP/+3VALWP	12/21	Antony	Solve S3/S5 acoustic noise issue	PR96 de-populate	X03
30	45	+5VALWP/+3VALWP	12/21	Antony	Solve S3/S5 acoustic noise issue	Add PR108 0 ohm	X03
31	48	+1.5VSP	12/23	Antony	Reserve CCM mode resistor	Reserve PR140 space	X04

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Title		
PWR-PIR2		
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		1.0
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Item	Date	Fixed Issue	Rev.	PG#	Modify List
01	2009/09/07	Enable N11P-GS1 +VGA_COREP when boot system	0.2	19	Mount R238 10K ohm pull high
02	2009/09/07	U3 pin SM_PWROK schematics error for DDR3	0.2	08	U3 pin SM_PWROK connect to +1.5V
03	2009/09/07	LVDS EDID can't switch select for panel	0.2	28	Modify U20,Q119,Q120 schematics and +LCDVDD change to +3VS
04	2009/09/07	GMCH L_BKLT_CTRL isn't inverted before MUXed	0.2	28	Remove U25 for net DPST_PWM
05	2009/09/07	Switch IC U4 pin1 can not enable	0.2	28	Remove R491 0 ohm and add mount R490 0 ohm
06	2009/09/07	Change HDMI connector	0.2	31	Change connector JHDMI1
07	2009/09/07	Change Display port connector	0.2	32	Change connector JDP1
08	2009/09/10	Change D-SUB connector	0.2	30	Change connector JCRT1
09	2009/09/10	Change SIM,WWAN,WLAN,FAN connector	0.2	33	Change connector JSIM1,JWWAN1,JWLAN1,JFAN1
10	2009/09/10	Change BTB connector	0.2	36	Change connector JBTB1
11	2009/09/10	Q26 footprint error	0.2	29	Change Q26 footprint
12	2009/09/10	Audio board move IHDA signal 33ohm to MB	0.2	18	Add R8,R46,R119,R120 33ohm
13	2009/09/16	LID switch move to audio board	0.2	36	Delete U2,C2,C3,R5
14	2009/09/16	Audio board ALC665 pin9 need +1.5VS	0.2	36	Change JBTB1 pin5,pin7,pin9 to +1.5VS
15	2009/09/17	Add +3VALW for ELC function LED power	0.2	36	Change JBTB1 pin8,pin10,pin12 to +3VALW
16	2009/09/17	LID SW move from MB to audio board	0.2	36	Change JBTB1 pin6 to LID_SW#
17	2009/09/17	Modify ELC schematics fllow DELL design	0.2	38	Modify ELC schematics
18	2009/09/17	Change D16,D25,D26,D31 to PJDLCO5C for EMI	0.2	29	Change BOM D16,D25,D26,D31 to SCA00001100
19	2009/09/17	DGPU +3VS_DELAY 漏電	0.2	21	Modify Q21 schematics
20	2009/09/18	Change R681 to 33ohm for EMI request	0.2	35	Change BOM R681 from 22ohm to 33ohm
21	2009/09/18	BOM mount L39,L40,L41,L42 for EMI request	0.2	31	Change BOM R579,R580,R581,R588,R591,R592,R595,R596 to @
22	2009/09/22	JP3 pin6,pin7(I2C) add PJDLCO5C for EMI	0.2	38	Add D30 to JP3 pin6 and pin7
23	2009/09/22	Add 0.1uF to SM_PWROK for EMI request	0.2	08	Add C190 0.1uF
24	2009/09/22	Modify JLAN1 GND for vender request for EMI	0.2	34	Add C1162,C1163 0.1uF
25	2009/09/22	For JMicro vender request	0.2	35	C1685 4.7uF near +3V_MCVCC
26	2009/09/22	DGPU +3VS_DELAY 漏電	0.2	21	Add Q58 and R389 to net VGA_CLKREQ#_R

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				Size	Document Number
				LA-5811P	1.0
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Item	Date	Fixed Issue	Rev.	PG#	Modify List
27	2009/09/23	Modify screw H12,H13,H17 for ME request	0.2	39	Modify screw H12,H13,H17
28	2009/09/23	Add +5VS for LED board power budget	0.2	39	Change JP3 pin9 from GND to +5VS
29	2009/09/23	Add 1000pF for EMI request	0.2	14	Add C115 1000pF
30	2009/09/23	Add 1000pF for EMI request	0.2	15	Add C196 1000pF
31	2009/09/24	Add 0.1uF on PCIE CLK for vender request	0.2	34	Add C1705,C1706 0.1uF
32	2009/09/24	Add 33ohm and 22pF for EMI request	0.2	35	Add 33ohm and 22pF to JCARD1 pin7,pin16
33	2009/09/24	Change crystal X1 cap. to 27pF	0.2	37	Change BOM C1616,C1617 from 15pF to 27pF(SE071270J8L)
34	2009/09/28	Modify USB powershre schematics	0.2	36	Move L43,R617,R618 near JUSB1
35	2009/09/28	Use the USB detect method for powershare	0.2	36	BOM need mount U60,D52,D58
36	2009/09/28	For CLKRUN# issue	0.2	37	Add U39 pin38 net PM_CLKRUN#
37	2009/09/28	Net SM_PWROK add 0.1uF near PU9 for EMC	0.2	48	Net SM_PWROK add C198 0.1uF
38	2009/09/28	Net SM_PWROK add 0.1uF near U3B for EMC	0.2	08	Net SM_PWROK add C190 0.1uF
39	2009/09/29	For RF request add 47pF for WLAN,WWAN +1.5VS	0.2	33	Add C1136,C1184 47pF to +1.5VS
40	2009/09/29	Intel request delete R27,R28,R29 for layout	0.2	05	Delete R27,R28,R29
41	2009/09/29	Add JLVDS1 connector detect pin	0.2	29	Add JLVDS1 pin32 LVDS_CONN,pin33 STATUS_BOARD_CONN
42	2009/09/30	Add JBTB1 connector detect pin	0.2	36	Add JBTB1 ppin33 IO_BOARD_CONN
43	2009/09/30	Add JP3 connector detect pin	0.2	38	Add JP3 pin15 STATUS_BOARD_CONN,pin16 IO_BOARD_CONN
44	2009/09/30	EC add JLVDS1,JBTB1,JP3 connector detect pin	0.2	37	Add LVDS_CONN to U39 pin18
45	2009/10/01	Add display port AUX schematics	0.2	32	Add Q123,Q124,Q125,R602,R603,R613,R614
46	2009/10/01	Add a FET for CPU overclocking	0.2	06	U39 pin25 add a net EC_FSB_SEL
47	2009/10/05	Add I2CB,I2CH pull high for NVIDIA request	0.2	15	Add R420,R421,R422,R423 pull high to +3VS_DELAY
48	2009/10/06	For Intel request change C1702 BOM	0.2	40	Change C1702 from 0.01uF to 0.1uF
49	2009/10/06	Change BOM error	0.2	23	Change C191,C192,C197,C261,C262,C263 from SE00000JM00 to SE00000MM1M
50	2009/10/08	Change Q35 Id to 300mA	0.2	23	Change Q35 from SB0000008J00 to SB0000003P10
51	2009/11/05	Change USB D+ and D-	0.3	36	Swap L43 USB signal USBP2_D-_C and USBP2_D+_C
52	2009/11/05	Change location R263 to C271	0.3	19	Change location R263 to C271 for layout.

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Item	Date	Fixed Issue	Rev.	PG#	Modify List
53	2009/11/05	Add 100K pull low for EC debug request	0.3	33	Add JWWAN1 pin49 R657 100K pull low to GND for net EC_TX
54	2009/11/05	Change BIOS ROM part to another PN	0.3	37	Change U41 BOM from SA00001IT0L to SA00002T00L
55	2009/11/09	Change C189,C195,C202 BOM	0.3	23	Change C189,C195,C202 PN from SE00000IS0A to SE076104K80
56	2009/11/09	Change C1105 BOM	0.3	36	Change C1105 PN from SE000000GK0 to SE000000GC0L
57	2009/11/09	Change C191,C192,C197,C261,C262,C263 BOM	0.3	23	Change C191,C192,C197,C261,C262,C263 PN from SE00000MM1M to SE076473K8L
58	2009/11/10	Add 10K pull high for LAN LED leakage	0.3	34	Add R662,R664 10K pull high to +3V_LAN
59	2009/11/10	Reserved 10K pull high for LID_SW#	0.3	37	Add R665 10K pull high to +3VALW
60	2009/11/10	Modify board ID	0.3	37	Mount R622 100K,R627 20K
61	2009/11/10	Modify U4 pin13,pin14	0.3	16	change R142,R352 to 22ohm,1%
62	2009/11/11	Reserved GPIO49 for DGPU_PWR_EN	0.3	19	Add R263,R268 0 ohm to net DGPU_PWR_EN
63	2009/11/11	For ESD request change D30 PN	0.3	38	Change D30 PN from SCA00001100 to SCA00000200
64	2009/11/12	Change R500 to 110ohm for LCD panel EA	0.3	29	Change R500 from 300ohm to 110ohm
65	2009/11/16	Modify JTP1 footprint for layout	0.3	39	Modify JTP1 footprint
66	2009/11/17	Add a 0603 size 0ohm for LVDS SW thermal	0.3	28	U19 pin 57 add a R329 0ohm to GND
67	2009/11/17	Reserved a jump for HDD 3.3V	0.3	32	Add a J3 to +3VS and C1628,C1634
68	2009/11/17	Change U42 pin8 from +5VS to +5VALW	0.3	38	Change U42 pin8 to +5VALW
69	2009/11/18	Reserved 0.1uF,22P for U42 pin6	0.3	38	Add R139,C1843,C313 to U42 pin6
70	2009/11/20	Net VGA_CLKREQ#_R 重複 pull H to +3VS_DELAY	0.3	21	BOM delete R406 10K ohm
71	2009/11/20	Change Q35 to AO3414 for +1.8VSDGPU 300mA	0.3	23	Change BOM Q35 from SB000003P10 to SB000007600
72	2009/11/20	Change Q11 to SI7121DN for +3VS_DELAY 1380mA	0.3	23	Change Q11 from SB923010020 to SB00000KI00
73	2009/11/20	U42 reserved 0.1uF for RF request.	0.3	38	Add C1857,C1858,C1859,C1860,C1861,C1862,C1863,C1864,C1865,C1866,C1867 0.1uF
74	2009/11/20	Change BOM error.	0.3	40	Change C1702 from 0.1uF to 0.01uF
75	2009/12/16	Modify board ID	1.0	37	Mount R628 37.4K and delete R627 20K
76	2009/12/16	Change DGPU_PWR_EN from GPIO18 to GPIO49	1.0	19	BOM mount R268 0 ohm and delete R263 0 ohm
77	2009/12/16	For DGPU thermal error modify power sequence	1.0	23	BOM mount R210,C207 and change R118 to 68K,C168 to 0.22uF
78	2009/12/16	For nVIDIA request change R571,R568 value	1.0	31	Change BOM R571,R568 from 10K(SD028100280) to 2.2K(SD028220180) or 4.7K

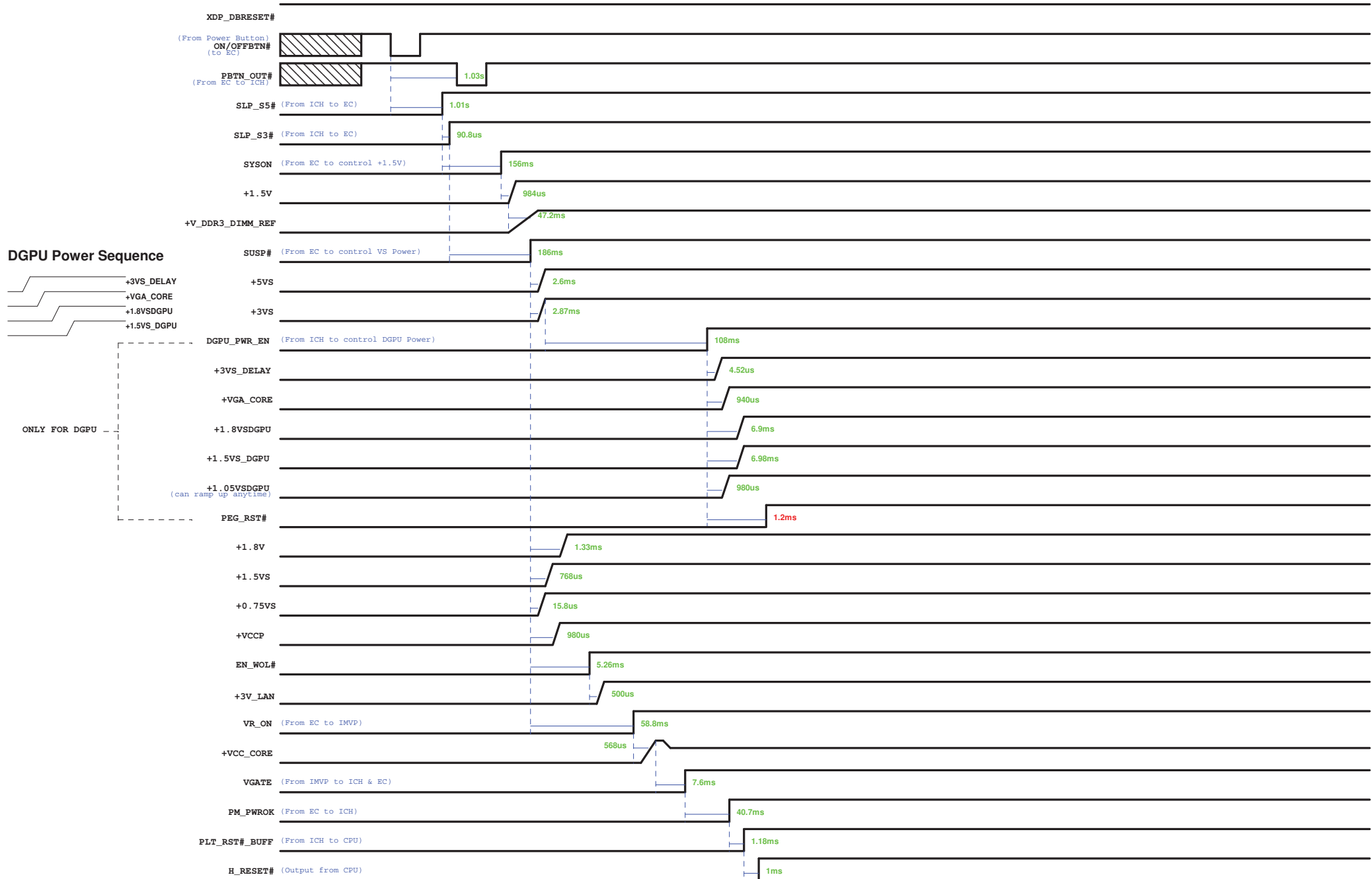
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Item	Date	Fixed Issue	Rev.	PG#	Modify List
79	2009/12/16	Change L52 part number	1.0	23	Change BOM L52 from SHI00006N0L to SHI00005V0L
80	2009/12/17	Change Q11 Compal PN	1.0	23	Change Q11 from SB00000KI00 to SB00000MK00
81	2009/12/18	Change L39,L40,L41,L42 PN for EMI	1.0	31	Change L39,L40,L41,L42 from SM070000K00 to SM070000I00
82	2009/12/20	Change C1616,C1617 to 18PF	1.0	37	Change C1616,C1617 from SE071270J8L to SE071180J80
83	2009/12/20	Change BOM for cost	1.0	11	Change C5,C84,C146 from SGA19331D10 to SGA00002680
84	2009/12/20	Change BOM for cost	1.0	12	Change C153 from SE124474KT0 to SE124474K80
85	2009/12/20	Change BOM for cost	1.0	12	Change C153 from SE000000GK0 to SE000003H00
86	2009/12/21	Change BOM for DELL 禁用料	1.0	23	Change C179,C245,C252,C492,C1664,C1693,C1694 from SE000000I10 to SE000001I10L
87	2009/12/21	Change BOM for DELL 禁用料	1.0	11	Change C93 from SE000008L80 to SE000008L0L
88	2009/12/22	Change BOM for DELL 禁用料	1.0	23	Change C72,C74,C210,C211,C215,C232,C237,C241,C258,C1514,C1519,C1528,C1532 from SE075103K80 to SE068103K8L
89	2009/12/22	Change BOM for DELL 禁用料	1.0	40	Change C1696,C1697 from SE075103ZN0 to SE068103K8L
90	2009/12/22	Change BOM for DELL 禁用料	1.0	07	Change C56,C57,C58 from SGA20221D40 to SGA20221E8L
91	2009/12/22	Change LVDS switch IC	1.0	28	Change U19 from SA00001RM0L to SA000030900
92	2009/12/22	Modify BOM for cost	1.0	32	BOM @ C1628,C1634
93	2009/12/22	Modify JKB1 footprint for 2nd source DFX	1.0	37	Modify JKB1 LTCX0020V0L footprint to TYCO_2-2041084-5_25P-T
94	2009/12/23	Change BOM for DELL 禁用料	1.0	17	Change U10 from SA007080B9L to SA007080B90
95	2009/12/23	Change BOM for DELL 禁用料	1.0	29	Change Q23,Q34,Q36,Q59 from SB000008J00 to SB570020110
96	2009/12/23	Change BOM for DELL 禁用料	1.0	23	Change Q10,Q12,Q46,Q47,Q52,Q56 from SB000009610 to SB00000960L
97	2009/12/28	Change BOM for DELL 禁用料	1.0	28	Change Q119,Q120,Q21,Q29,Q30 from SB00000AR00 to SB57002528L
98	2009/12/28	Change BOM for DELL 禁用料	1.0	19	Change Q8,Q9 from SB502060000 to SB50206008L
99	2009/12/28	Change BOM for DELL 禁用料	1.0	29	Change Q28,Q58 from SB570020020 to SB57002008L
100	2009/12/28	Change BOM for DELL 禁用料	1.0	29	Change Q26 from SB570020400 to SB57002041L
101	2009/12/28	Change BOM for DELL 禁用料	1.0	40	Change Q51,Q53,Q54 from SB570025280 to SB57002528L
102	2009/12/28	Change BOM for DELL 禁用料	1.0	11	Change D1,D13,D15,D5,D6 from SC1H751H01L to SC1SS355010

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## NAP00 Power On Sequence



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